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DETERMINATION OF NATIVE DEFECTS AND ENDOTAXIAL GROWTH OF METAL-METALLOID CRYSTAL SYSTEMS
EXPERIMENTAL RESULTS IN TiO₂ (RUTILE)

N. E. FARB
NAVIGATION SYSTEMS DIVISION
AUTONETICS
A DIVISION OF NORTH AMERICAN AVIATION, INC.


SEPTEMBER 1965

Air Force Materials Laboratory
Research and Technology Division
Air Force Systems Command
Wright-Patterson Air Force Base, Ohio
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400 - November 1965 - 18-322-773
DETERMINATION OF NATIVE DEFECTS AND ENDOTAXIAL GROWTH OF METAL–METALLOID CRYSTAL SYSTEMS
EXPERIMENTAL RESULTS IN TiO₂ (RUTILE)

N. E. FARBER
NAVIGATION SYSTEMS DIVISION
AUTOMETICS
A DIVISION OF NORTH AMERICAN AVIATION, INC.
FOREWORD

This report was prepared by the Navigation Systems Division, Autonetics, Anaheim, California, under USAF Contract No. AF33-(615)1552. This contract was initiated under Project No. 7350, titled "Refractory, Inorganic Non-metallic Materials", Task No. 735001, "Non-Graphitic". The work was administered under the direction of the Air Force Materials Laboratory, Metals and Ceramics Division, with L. L. Fehrenbacher acting as project scientist.

This report covers work conducted from May 1964 to June 1965.

This technical document has been reviewed and approved.

W. G. Ramke
Chief, Ceramics and Graphite Branch
Metal and Ceramics Division
Air Force Materials Laboratory
ABSTRACT

This work was undertaken so that an understanding of the anomalous nonstoichiometric and high temperature behavior of TiO$_2$ (rutile) could be ascertained. The experiment was of such a nature that the question (which has been a subject of controversy for years) concerning the type of defect—that is, whether the nonstoichiometric defect was cation interstitials or oxygen vacancies, could be answered immediately. The defect that had been considered in most of the early work (oxygen vacancies) was not the predominant effect found in this experiment. The result of the experiment was a crystalline regrowth on the high partial pressure O$_2$ surface. The course of the work followed an initial experimental program to determine which of the two assumptions was correct, then a combination of theoretical and experimental correlation, and, finally, a theoretical study to outline a general tool for the determination of the native imperfections in metal-metalloid crystal systems in a single experiment. Experimental results also yielded experimental proof of a new purification technique for TiO$_2$, and the results are applied by theoretical discussion to other metal-metalloid systems. The regrowth of single crystal TiO$_2$ in this experiment also leads, by a simple extension, to an entirely new and, as yet, unexplored method of growing single crystals. This is also discussed theoretically. The growth of polycrystalline samples also points to the possibility of new techniques in producing 100 percent theoretical density polycrystalline material. This experiment has also yielded a new method of revealing dislocations in metal-metalloid crystals. The method is discussed theoretically.

The results obtained yield a physical proof of the existence of titanium interstitials in nonstoichiometric TiO$_2$ and an understanding of previous experimental inconsistencies.
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1. INTRODUCTION

The theoretical determination of the type and degree of nonstoichiometry cannot at this time be determined from first principles. In fact, a satisfactory theory of the cohesive properties of solids does not exist. A completely satisfactory theory of the cohesive properties of solids would necessarily include the theoretical determination of the type and degree of nonstoichiometry a crystal would have in equilibrium with its environment.

The determination of the type and degree of nonstoichiometry by experimental techniques has led to different conclusions in all the thoroughly studied systems. Several reviews, articles, and chapters of textbooks have been written on this subject. (References 1-5) For example, one class of experiments dealing with the electrical properties will differ from the logical conclusions drawn from diffusion experiments.

The usual experimental techniques used to determine nonstoichiometry in metal-metalloid crystal systems can be listed where in all cases the magnitude and sign of the variation in the property is measured versus partial pressure.*

Variation of

1. Conduction
   a. Electronic
   b. Ionic
2. Hall effect as \( f(T) \)
   a. Electronic
   b. Ionic (has been attempted)
3. Thermoelectric power as \( f(T) \)
4. Tarnishing reactions

*Except No. 3 in certain cases
5. Loss of weight
   a. Thermogravimetry

6. Change in density
   a. Pycnometry
   b. X-ray techniques

7. Optical properties
   a. Absorption
   b. Fluorescence
   c. Polarization
   d. Thermoluminescence

8. Self-diffusion

9. Internal friction

10. Dielectric constant and loss

   The key reason that confrontation of results exists is the word variation. Many simplifying assumptions necessarily have to be made in theoretical derivations to ascertain which of the four native imperfections--metal atom or ion vacancies or interstitials, metalloid atom or ion vacancies or interstitials (antistructure disorder will only be considered briefly)--yields the magnitude and sign of the variation in the measured property versus the partial pressure. These assumptions, for example, assume that:

   1. Imperfections are ionized at a particular level so that they all affect the electrical properties, or that the ratio of ionized to unionized defects is large

   2. The defect-defect interaction is small and can be neglected (Henry's Law and Raoult's Law)

   3. One or the other type of defect leads to donors and acceptors
4. The rate of growth of a tarnished layer on a metal corresponds to interstitial or vacancy diffusion because of the value of \( D \) or \( D_0 \).

5. The self-diffusion occurs by one or the other diffusion mechanisms.

6. The optical properties correspond to one or the other ionized or unionized states.

However, from the entire spectrum of experimental data, some basic facts are clearly established:

1. Native imperfections do exist.
2. Diffusion does occur because of imperfections.
3. Diffusion of an imperfection species will occur under a concentration gradient of that species (Ficks' Law) if the imperfection species diffusion is the rate limiting process.
4. The sign of the variation of the imperfection concentration with partial pressure can be determined (the magnitude of the slope being unimportant). Stated in other words, the law of mass action will determine that the concentration of imperfections is either directly or inversely proportional to some power of the partial pressure of the gas in equilibrium with the solid. The conclusions arrived at by the experimental technique described in this report are independent of the absolute value of the fractional value of the partial pressure exponent.
5. Different imperfection concentration gradients can be determined by conventional techniques, i.e., some physical property other than diffusion is either directly or indirectly proportional to the concentration of the imperfections. Again, the absolute value of the physical property dependency upon partial pressure is not needed.

Using these facts, an experimental technique has been developed to yield a physical proof of the type or types of imperfections present in a crystal system. It must be emphasized that this determination is not dependent upon (1) the magnitude of the slope, (2) the relative degree of ionization, or (3) inferences from quantitative diffusion measurements as to whether the diffusion is by interstitial or vacancy mechanisms. In certain crystals there may be a large
difference in the activation energy for motion. In this instance, the
greatest rate of crystal growth may be due to a specie which does not
have the greatest concentration. However, this specie would be the
most important defect as far as mass transport is concerned.

Regrowth of the crystal will occur when the imperfections
associated with the metal or metalloid are present. This type of
regrowth on a single crystal has never been experienced except
indirectly in tarnishing reactions. Purification of the crystal is also
experienced. For background information regarding crystal growth
and diffusion, see References 4 and 5 for crystal growth, and
References 7 and 8 for diffusion. For background information con-
cerning the direct observations of dislocations see Reference 9. In
addition, this technique offers the possibility of sweeping out line
and surface imperfections by a technique discussed in the theoretical
section. Excellent background for this can be ascertained from
Reference 6.

The TiO$_2$ body centered tetragonal (rutile) crystal system was
used in the experimental portion of this work (4/28/64 to 4/28/65).
This crystal system has been investigated considerably. The results
of these investigations have led to different conclusions. Weight loss
measurements by Buessem and Butler, Reference 10 and by Kofstad,
Reference 11, led to the conclusion that oxygen vacancies were the
predominant defect. Conductivity and thermoelectric measurements
by Yahia, Reference 12, led to the conclusion that titanium interstitials
were present below an O$_2$ partial pressure of 10 mm Hg and oxygen
vacancies were present above this value. Hall and Just (Reference 13)
measured the self-diffusion of oxygen by $^18$ mass spectrographic
techniques to be

$$D = 1.1 \exp (-3.13 \text{ ev/KT}).$$

This value did not correlate directly with the experimental time
required to reach a new value of nonstoichiometry, as reported by
various investigators (References 10 and 11), even considering the
difference between mass and self-diffusion. The fast diffusion
indicated by these equilibrium times implies that a membrane experi-
ment using steady state mass diffusion is possible, and that if there
was a titanium imperfection, crystal regrowth would occur. The
latter was found to be true.
II. THEORETICAL DISCUSSION

A perfect crystal is considered to be constructed by the infinite regular repetition in space of identical structural units. The smallest structural unit possible is the primary unit cell, which contains the ratio of atoms associated with the crystal. (This discussion will only consider metal-metalloid crystal systems of the form $M_aX_b$.)

However, an alternative consideration from an imperfection study standpoint is the view that a perfect $M_aX_b$ crystal has atoms and vacant spaces associated with an infinite point set of interposed sublattices. The point sets can be associated with the center of the volumes normally occupied by atoms, and the point set associated with the center of the normally vacant interstitial volumes. The interstitial volumes can sometimes be associated with the normally occupied sublattice positions. Each sublattice is composed of an infinite set of points with a corresponding volume. Thus, in the $M_aX_b$ crystal system it is assumed:

1. $M_M$ Normally occupied,
2. $X_X$ Normally occupied,
3. $V_i$ Normally unoccupied interstitial position.

Imperfections can be classified according to relative dimensions as:

1. Point defects - of atomic size in three directions,
2. Line defects - of atomic size in two directions,
3. Surface defects - of atomic size in one direction.

Point defects can be subdivided into:

1. Atomic defects,
2. Electronic defects
3. Associated atomic-electronic defects.
Atomic defects can be subdivided into:

(1) Native and Foreign Atomic Imperfections

a. \( V_M^X \) - vacancy at a normally occupied M lattice position\(^*\),
b. \( V_X^M \) - vacancy at a normally occupied X lattice position,
c. \( M_{i}^X \) - M atom at a normally unoccupied interstitial \((V_i)\) position,
d. \( X_{i}^M \) - X atom at a normally unoccupied interstitial position,
e. \( F_{M}^X, F_{X}^M, F_{i}^X \) - Foreign atom at an M, X, or \((V_i)\) position.

(2) Electronic Imperfection

a. \( e' \) - quasi free electron in conduction band,
b. \( h' \) - quasi free hole in valence band,
c. The symbols \( ^{+}, ^{-}, ^{X} \) indicate a negative, positive or neutral charge.

(3) Associated Defects

a. \( V_{M}', V_{M}^2, V_{X}', V_{X}^2 \), etc.
b. \( (V_{M}M_{i})^X, (V_{X}X_{i})^X, (V_{M}V_{X})^X \), etc.

The definition of deviation from stoichiometry will be defined by the equation

\[
\Lambda = \frac{a}{b} \left\{ \frac{[X]}{[X]_{total}} - \frac{[V]}{[V]_{total}} - \frac{[M]}{[M]_{total}} - \frac{[V_{M}]}{[V_{M}]_{total}} \right\} \tag{1}
\]

If \( \Lambda = 0 \), the crystal is stoichiometric.

*The symbol \(^X\) indicates a neutral charge.
A. DETERMINATION OF IMPERFECTIONS IN A METAL-METALLOID SYSTEM.

Consider the experimental arrangement as shown in Figure 1. A polished crystalline sample membrane is placed inside a precision ground non-interacting ceramic ring and between two non-interacting metal washers. These components act as a gas seal between the impervious ceramic tubes and the disc sample. A partial pressure of $X_2$ is maintained on surface 1 greater than on surface 2, $(p_{X_2})_1 > (p_{X_2})_2$. The entire assembly is placed inside a furnace.

For ionic conduction, the two surfaces would be electrically connected externally.

1. Surface Equilibrium Conditions

Let us now only consider vacancies and interstitials in the sublattices. For the moment, let us only consider those systems that exhibit only one predominant type of non-stoichiometric atomic defect in the partial pressure range of interest, and that the defect is nonionized. In this case the various solid state-gas reactions and their equilibrium are as follows:

2. Case 1. Metal Interstitials:

$$M_aX_b + SM(g) = M_a(SM_i)X_b$$

or

$$M(g) = M_i$$

thus

$$\left[ \frac{M_i}{p_{M_i}} \right]_{ij} = (K_{M_i})_{ij}$$

but

$$M_aX_b = aM(g) + \frac{b}{2}X_2(g)$$

therefore

$$\left( \frac{b}{p_{M_i}^a} \right)_{ij} \left( \frac{p_{X_2}^a}{(p_{X_2})_2} \right)_{ij} = (K_{M_iX_2})_{ij}$$
since

$$[M_a X_b]_j = 1$$

where the structural notation of Kroger and Vink (Reference 4) has been followed, and $j$ indicates the surface ($j = 1, 2$). Henry's law will be assumed to be true for the moment. If $(p_{X_2})_{1/2} > (p_{X_2})_{1/2}$, (8) the concentration of $[M_i]_2 > [M_i]_1$ (9) by the relation using Equations 3 and 5

$$[M_i]_2 = \frac{(K_{M_i}^{1/a})_2 (K_{MX}^{1/a})_2 (p_{X_2})^{b/2a}_1}{(K_{M_i}^{1/a})_1 (K_{MX}^{1/a})_1 (p_{X_2})^{b/2a}_2} [M_i]_1$$

The equilibrium constants do not cancel unless the temperature and free energies are the same. It will be shown later that, indeed, the surface reactions are different resulting in exothermic and endothermic reactions which modify the equilibrium surface temperatures.
3. Case 2: Metal Vacancies:

\[ \frac{b}{2} X_2(g) \rightarrow b X + a V_M \]  \hspace{1cm} (11)

The equilibrium constant can be written as

\[ \frac{[V_M^a]}{b} = (K_{VM})_j \]  \hspace{1cm} (12)

The relation between the equilibrium values on the two surfaces is now

\[ [V_M]_1 = \frac{\frac{1}{a}}{(K_{VM})_1} \frac{\frac{b}{2a}}{(K_{VM})_2} \frac{1}{(p_{X_2})_1} \frac{1}{(p_{X_2})_2} [V_M]_2 \]  \hspace{1cm} (13)

Thus, if

\[ (p_{X_2}^{b/2})_1 > (p_{X_2}^{b/2})_2 \]  \hspace{1cm} (14)

then

\[ [V_M]_1 > [V_M]_2 \]  \hspace{1cm} (15)

which is opposite to the relation for metal interstitials.

4. Case 3. Metalloid Interstitials:

\[ M_a X_b + \frac{\delta}{2} (X_2)_g \rightarrow M_a X_b (\delta X_1) \]  \hspace{1cm} (16)

or

\[ \frac{1}{2} (X_2)_g \rightarrow X_1 \]  \hspace{1cm} (17)
Thus,\[ [X_1]_j = (K_{X_1})_j (p_{X_2}^{\frac{1}{2}})_j \]  \hspace{1cm} (18)

Thus,\[ [X_1]_1 = \frac{(K_{X_1})_1 (p_{X_2}^{\frac{1}{2}})}{(K_{X_1})_2 (p_{X_2}^{\frac{1}{2}})} [X_1]_2 \]  \hspace{1cm} (19)

and if\[ (p_{X_2}^{\frac{1}{2}})_1 > (p_{X_2}^{\frac{1}{2}})_2 \]  \hspace{1cm} (20)

then\[ [X_1]_1 > [X_1]_2 \]  \hspace{1cm} (21)

5. Case 4. Metalloid Vacancies:

\[ X = \frac{1}{2} X_2 (g) + V_X \]  \hspace{1cm} (22)

Thus,\[ \frac{1}{2} (p_{X_2}^{\frac{1}{2}})_j [V_X]_j = (K_{V_X})_j \]  \hspace{1cm} (23)

or\[ [V_X]_j = (K_{V_X})_j (p_{X_2}^{\frac{1}{2}})_j \]  \hspace{1cm} (24)

therefore\[ [V_X]_1 = \frac{(K_{V_X})_1 (p_{X_2}^{\frac{1}{2}})_1}{(K_{V_X})_2 (p_{X_2}^{\frac{1}{2}})_2} [V_X]_2 \]  \hspace{1cm} (25)

and if\[ (p_{X_2}^{\frac{1}{2}})_1 > (p_{X_2}^{\frac{1}{2}})_2 \]  \hspace{1cm} (26)
then

\[ [y_x]_2 > [y_x]_1 \]  

(27)

In summary then if

\( (p_{X_2})_1 > (p_{X_2})_2 \),

(28)

(assuming equal temperatures here) then,

\[ [M_1]_2 > [M_1]_1 \]  

(29)

\[ [v_M]_1 > [v_M]_2 \]  

(30)

\[ [x_1]_1 > [x_1]_2 \]  

(31)

\[ [y_x]_2 > [y_x]_1 \]  

(32)

6. **Diffusion**

The above differences in concentration of imperfections results in a concentration gradient across the membrane which will result in a diffusion of that species. This diffusion can be depicted in the four cases as shown in Figure 2.

Let us now consider case 1 and 2, (i.e.) the metal defects. If one uses Fick's Law where the diffusion is independent of concentration and the crystal is at a uniform temperature,

\[ j = -D \frac{dc}{dx} \]  

(33)

Fick's Law for case No. 1 is

\[ j_{Mi} = -D_{Mi} \frac{d[M_i]}{dx} \]  

(34)

For case No. 2 it is

\[ j_{VM} = -D_{VM} \frac{d[V_M]}{dx} \]  

(35)
METAL INTERSTITIALS:

\[ (p_{X_2})_1 > (p_{X_2})_2 \]

METAL VACANCIES:

\[ (p_{X_2})_1 > (p_{X_2})_2 \]

METALLOID INTERSTITIALS:

\[ (p_{X_2})_1 > (p_{X_2})_2 \]

METALLOID VACANCIES:

\[ (p_{X_2})_1 > (p_{X_2})_2 \]

Figure 2. Diffusion Schematic Representation - Dashed Slopes Represent Equilibrium Conditions
Now \( \frac{d[M_1]}{dx} > 0 \) and \( \frac{d[V_M]}{dx} < 0 \) so that for either case \( j > 0 \) resulting in a diffusion of metal atoms towards surface 1. Diffusion of vacancies in one direction is equivalent to diffusion of atoms in the opposite direction i.e. \( j_{VM} = -j_{M} \).

For case 3 and 4 Fick's Law can be written

\[
j_X = -D_X \frac{d[X]}{dx}
\]

and

\[
j_{VM} = -D_{VM} \frac{d[V_X]}{dx}
\]

but again

\( \frac{d[X_i]}{dx} < 0 \) and \( \frac{d[V_X]}{dx} > 0 \) so that in either case metalloid atom \( i \) move toward surface 2. Again \( j_{VM} = -j_X \).
7. Growth from Metal-Atom Interstitials

Now, reconsider case No. 1 and No. 2 where metal atom imperfections are moving resulting in a mass diffusion of metal atoms towards surface 1. Case 1 has metal atom interstitials moving from surface 2 which is in equilibrium with a low partial pressure of $(P_{X_2})_2$ to the surface where the partial pressure $(P_{X_2})_1$ is higher. The resulting concentration of $M_i$ (due to diffusion) is, therefore, higher than the equilibrium concentration at surface 1, and the excess interstitials react with the $X_2$ gas atoms driving the following equation from right to left.

$$(1 - \delta_D) M_a + \delta_1 X_b \rightarrow M_a + \delta_1 X_b + \delta_D (M_i + \frac{b}{2} X_2 (g))$$

where $\delta_D$ is the excess concentration of $M_i$ above $\delta_1$ at surface 1 due to diffusion. Thus, the crystal grows on the high partial pressure $X_2$ surface. The low partial pressure surface continues to supply metal-atom interstitials in an attempt to maintain equilibrium on this surface. This is equivalent to the above equation being driven from left to right with

$$\delta_1 \rightarrow -\delta_D \text{ and } \delta_1 \rightarrow \delta_2$$

or

$$(1 - \delta_D) M_a + \delta_2 X_b \rightarrow M_a + \delta_2 X_b - \delta_D (M_i + \frac{b}{2} X_2 (g))$$

(39)

8. Growth from Metal Atom Vacancies

The atomic details of this process proceed as follows. A metal atom near the surface is promoted to the surface by thermal stimulation. The crystal in the presence of $X_2$ gas has a certain fraction of its surface sites occupied by $X$ atoms (chemisorption, adsorption), and thus can react and form a $M_aX_b$ unit cell. The process also can occur by a collision with an $X_2$ molecule with the $M$ surface atom. The following equation proceeds from left to right.

14
The high concentration of \( [V_M]_1 \) on surface 1 diffuses towards surface 2 where the equilibrium concentration of \( [V_M]_2 \) is now imbalanced, and the above equation proceeds from right to left resulting in an annihilation of metal atom vacancies and an evolution of \( \delta b X_2 \) gas molecules. Thus, crystal growth is obtained on the high pressure side, there is mass diffusion of cations in the cation sub-lattice through the membrane, \( X_2 \) gas molecules are deposited on the high pressure side, and \( X_2 \) gas molecules are released on the low pressure side that were originally crystal anions.

9. **Metalloid Interstitials Diffusion**

This does not directly result in crystal growth if a low partial pressure of \( X_2 \) is used. The equilibrium concentration of metalloid interstitials is higher on the high pressure surface (1), and metalloid interstitials diffuse through the crystal resulting in a higher than equilibrium concentration at surface two. Thus, at surface 1 Equation 15 is driven from left to right, and at surface 2 Equation 15 is driven from right to left. This results in an evolution of \( X_2 \) gas molecules at surface two.

10. **Metalloid Vacancies Diffusion**

This also does not directly result in crystal growth if a low partial pressure of \( X_2 \) is used. The concentration of metalloid vacancies is higher on the low partial pressure surface, and the diffusion of metalloid vacancies proceeds towards the high pressure surface. Here again, the equilibrium concentration of vacancies is lower so that metalloid vacancies are annihilated at this surface and are replaced by \( X \) atoms on the surface (chemisorbed or adsorbed) or from collision with an \( X_2 \) gas molecule.

The results are tabulated in the first three columns of Table 1.
<table>
<thead>
<tr>
<th>Crystal Growth</th>
<th>Imperfection Gradient</th>
<th>Diffusion Mechanism</th>
<th>Surface 1 Reaction</th>
<th>Surface 2 Reaction</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>( \frac{d[M]}{dx} &gt; 0 )</td>
<td>Interstitially</td>
<td>Highly Endothermic</td>
<td>Exothermic</td>
</tr>
<tr>
<td></td>
<td>( \frac{d[V]}{dx} &lt; 0 )</td>
<td>Vacancy</td>
<td>Endothermic</td>
<td>Exothermic</td>
</tr>
<tr>
<td>Metal Atom</td>
<td>No</td>
<td>Interstitially</td>
<td>No</td>
<td>Exothermic</td>
</tr>
<tr>
<td>Interstitials</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Metal Atom</td>
<td>No</td>
<td>Interstitially</td>
<td>No</td>
<td>Exothermic</td>
</tr>
<tr>
<td>Vacancies</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Metalloid</td>
<td>No</td>
<td>Interstitially</td>
<td>No</td>
<td>Exothermic</td>
</tr>
<tr>
<td>Interstitials</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Metalloid</td>
<td>No</td>
<td>Interstitially</td>
<td>No</td>
<td>Exothermic</td>
</tr>
<tr>
<td>Vacancies</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
From the above results one can readily determine the type of imperfection prevalent in a crystal. If crystal growth occurs, the imperfection is either metal atom vacancies or metal atom interstitials. If crystal growth does not occur and loss of $X_2$ gas on the high pressure side occurs, the imperfection is either metalloid vacancies or metalloid interstitials. To separate the two possibilities, i.e., metal atom interstitials from metal atom vacancies, when crystal growth occurs, the concentration gradient across the membrane must be determined. A rapid quenching from high temperatures will freeze in the concentration gradient. The membrane can then be cut so as to reveal a cross section, or thinner membranes can be cut from the original membrane. Then, some physical parameter such as optical absorption, conductivity, etc. that varies with the concentration of the imperfection can be measured to determine the concentration gradient. The concentration gradient being greater than zero indicates metal atom interstitial imperfections. A concentration gradient less than zero indicates a metal atom vacancy imperfection.

In a similar manner if crystal growth does not occur, the separation of metalloid vacancies from metalloid interstitials can be determined from the concentration gradient, being $> 0$ (metalloid vacancies) or $< 0$ (metalloid interstitials). In the determination of the concentration gradient by some physical property due to the imperfections, the only fact required is that the physical property be directly or indirectly proportional to the concentration of imperfections. The magnitude of the proportionality is not important. Thus, the five elementary assumptions have been employed to determine the type of defect.

Consider now the individual surface reactions at each face in regard to type of chemical reaction—that is, exothermic or endothermic reactions. In each of the four cases the imperfections are created at one surface and annihilated at the other surface. Metal atom interstitials and metalloid vacancies are formed at the low partial pressure surface; metal atom vacancies and metalloid interstitials are formed on the high partial pressure surface and annihilated at the low partial pressure surface. The creation of the imperfections requires energy in each case and the annihilation releases energy in each case. Here, a detailed analysis of an appropriate Born-Haber cycle for an ionic or covalent crystal would have to be analyzed, but, in general, the creation of imperfections requires energy.
If the creation of imperfections requires energy, then the reaction of case 1 on surface 2 (forming metal interstitials) will be endothermic, and surface 1 will be exothermic. The reaction of case 2 on surface 1 (forming metal vacancies) will be endothermic, and surface 2 will be exothermic. The reaction of case 3 on surface 1 will be endothermic (forming metalloid interstitials), and surface two will be exothermic. The reaction of case 4 on surface 2 will be endothermic (forming metalloid vacancies), and on surface 1 will be exothermic.

These reactions and their associated changes in local temperature, from the ambient, will change the equilibrium constants so that the resulting concentration gradients are always reduced in absolute magnitude. Therefore, the mass diffusion is reduced by this consideration. However, the temperature gradient is always of a nature to aid the mass diffusion. Thus, these competing effects will result in a new temperature and concentration gradient in the steady state. The resulting equilibrium concentration and temperature gradients are indicated in Figure 2 by dash lines. The results are summarized in the last three columns of Table 1.

In some crystal systems deviations from stoichiometry may occur at some partial pressure \( p_{X_2} \) that is spanned by \( p_{X_2} \) and \( p_{X_2} \) or

\[
(p_{X_2})_1 > (p_{X_2})_s > (p_{X_2})_2 \tag{41}
\]

In this situation, the prevalent type of imperfection may differ on each side of the crystal. This can lead to some interesting situations. Since we are considering four different types of imperfections on two surfaces, the number of situations we have not considered so far is \( 4^2 - 4 \) or 12 different situations. However, of these 12, only four are possible. This can be seen from the matrix of Table 2.

Cases 1 through 4 have already been considered, and case (Z) is equivalent to the inverse of case (Z + 6). Some of these situations, however, are not likely. These are indicated by an N in the matrix element. Cases 13, 15, and 16 are not likely, because this would indicate that

\[
[V_X] \propto (p_{X_2})_1 \tag{42}
\]
### Table 2. Imperfection Matrix

<table>
<thead>
<tr>
<th>Surface 2 (P(X_2))_2</th>
<th>Metalatom Interstitials</th>
<th>Metalatom Vacancies</th>
<th>Metalloid Interstitials</th>
<th>Metalloid Vacancies</th>
</tr>
</thead>
<tbody>
<tr>
<td>Surface 1 (P(X_2))_1</td>
<td>Case 1 **</td>
<td>Case 5 **</td>
<td>Case 6 **</td>
<td>Case 7 **</td>
</tr>
<tr>
<td></td>
<td>Y</td>
<td>N*</td>
<td>N*</td>
<td>N*</td>
</tr>
<tr>
<td>Metal Atom Interstitials</td>
<td>Case 11 **</td>
<td>Case 2 **</td>
<td>Case 8 **</td>
<td>Case 9 **</td>
</tr>
<tr>
<td></td>
<td>Y</td>
<td>Y</td>
<td>N*</td>
<td>Y</td>
</tr>
<tr>
<td>Metal Atom Vacancies</td>
<td>Case 12 **</td>
<td>Case 14 **</td>
<td>Case 3 **</td>
<td>Case 10 **</td>
</tr>
<tr>
<td></td>
<td>Y</td>
<td>N*</td>
<td>Y</td>
<td>Y</td>
</tr>
<tr>
<td>Metalloid Atom Interstitials</td>
<td>Case 13 **</td>
<td>Case 15 **</td>
<td>Case 16 **</td>
<td>Case 4 **</td>
</tr>
<tr>
<td></td>
<td>N*</td>
<td>N*</td>
<td>N*</td>
<td>Y</td>
</tr>
</tbody>
</table>

N* ≈ not likely
**Nondiagonal elements assumed \((P_{X_2})_1 > (P_{X_2})_s > (P_{X_2})_2\)

rather than

\[
[V_X] \propto (P_{X_2})_{1}^{-\frac{1}{2}}, \quad \text{(in contradiction to the law of mass action)}
\]

when

\[
\frac{1}{2} \left[ \frac{1}{2} \right] > \frac{1}{2} \left[ \frac{1}{2} \right]
\]

Cases 5 and 14 are not likely, because this would indicate that

\[
[V_M] \propto (P_{X_2})_{2}^{-\frac{1}{2}}
\]

(45)

rather than

\[
[V_M] \propto (P_{X_2})_{2}^{-\frac{1}{2}} \quad \text{(in contradiction to the law of mass action)}
\]

(46)
when
\[ \frac{1}{2} (P_{X_2})_s > \frac{1}{2} (P_{X_2})_2. \] (47)

Cases 6 and 8 are not likely, because this would indicate that
\[ [X_i] \propto \frac{1}{2} (P_{X_2})_2 \] (48)
rather than
\[ [X_i] \propto \frac{1}{2} (P_{X_2})_2 \] (in contradiction to the law of mass action) (49)
when
\[ \frac{1}{2} (P_{X_2})_2 < \frac{1}{2} (P_{X_2})_s \] (50)

Case 7 is not likely, because this would indicate that
\[ [M_i] \propto \frac{1}{2} (P_{X_2})_1 \] (51)
rather than
\[ [M_i] \propto \frac{1}{2} (P_{X_2})_1 \] (in contradiction to the law of mass action) (52)
when
\[ \frac{1}{2} (P_{X_2})_1 > \frac{1}{2} (P_{X_2})_s \] (53)

Thus, only four other diffusion problems need to be considered--Cases 9, 10, 11, and 12.

11. Consideration of Case 9

Anion vacancies are created at surface 2 and diffuse toward surface 1. Cation vacancies are created at surface 1 and diffuse toward surface 2. This would result in void formation internally in the crystal (because of association of \( V_+ \) and \( V_- \)) with growth on the oxidizing side and loss of \( X_2 \) gas in the high partial pressure chamber due to growth. Schottky equilibrium is not involved here because the
formulation of the Schottky equation assumes the equilibrium transfer of atoms M and X from normal lattice sites to new sites at the surface of the crystal by the equation. (4)

\[ 0 \rightarrow V_M^x + V_X^x \]  

with

\[ [V_M^x] [V_X^x] = K_S \] (55)

The steady-state diffusion of \( V_M \) from one surface and \( V_X \) from the other surface will result in internal equilibrium by the reaction:

\[ nV_M^x + mV_X^x = (nV_M^x mV_X^x) \] (56)

with

\[ \frac{[(nV_M^x mV_X^x)]}{[V_M^x]^n [V_X^x]^m} = K_7 \] (57)
At the plane of association of $V_M$ and $V_X$ defined by the
following equation which is derived later (see Equation 82).

\[
x = \frac{\ell}{a D_V \left[ \frac{V_X}{V_M} \right]_2 + b D_V \left[ \frac{V_X}{V_M} \right]_1}
\]  

The following sequence of steps will occur (see Figure 3).

1. A disc void will be created (the shape depends upon the
   surface free energies).

2. The continued diffusion of metal vacancies from surface one
   will be annihilated at the void with resulting release in the
   void of $X_2$ by the reaction

\[
V_M + X_X \rightarrow \frac{1}{2} X_2
\]

3. Thus the partial pressure of $X_2$ due to the surface 1 side
   of the void will be higher than the partial pressure of $X_2$
   due to the surface 2 side of the void where $V_X$ imperfections
   are arriving from surface 2.

4. Thus there will be gaseous transport of $X_2$ across the void
   tending to equilibrate the surface 2 side of the void.

5. Since the condition for the stoichiometric plane of assoc-
   iation was $j_{V_M} = j_{V_X}$, the $X_2$ gas molecules will be
   just sufficient for the continued transport of $X_X$ through the
   entire crystal (assuming surface reaction rates unimportant).

6. Thus, the surface 2 side of the void remains stationary but
   the surface 1 side of the void continues to move toward the
   original $x = 0$ position. This is depicted in Figure 3.
Figure 3. Case 9--Diffusion Result

12. Consideration of Case 10

Metalloid vacancies are created at surface 2 and diffuse towards surface 1. Metalloid interstitials are created at surface 1 and diffuse toward surface 2. Annihilation of metalloid vacancies and interstitials can occur internally by association. No crystal growth would normally occur.

\[ \text{V}_X + X_i \rightarrow O. \]  

(60)

13. Consideration of Case 11

Metal atom interstitials are formed at surface 2 and diffuse towards surface 1. Metal atom vacancies are formed at surface 1 and diffuse toward surface 2. Crystal growth occurs on surface 1, and annihilation of metal atom vacancies and interstitials will occur internally.

\[ \text{V}_M + M_i \rightarrow O. \]  

(61)
14. Consideration of Case 12

Metalloid interstitials are formed at surface 1 and diffuse toward surface 2. Metal atom interstitials are formed at surface 2 and diffuse toward surface 1. Crystal growth could occur, and the loss of $(X_2)_1$ gas is the result of crystal growth on surface 1 and the diffusion of anion interstitials to surface 2 where they are liberated. This case would be a particularly interesting diffusion problem to determine if there is a different "interstitial sublattice" for cations and anions and a p-n junction is likely to be formed if there is not a different sublattice. Also, association of $M_1$ and $X_1$ is likely to occur that will reduce the diffusion rate. The results are summarized in Table 3.

Table 3. Diffusion Results if There Exists a Stoichiometric Partial Pressure Spanned by $(P_{X_2})_1$ and $(P_{X_2})_2$

<table>
<thead>
<tr>
<th></th>
<th>Crystal Growth</th>
<th>Metalloid Atom Diffusion</th>
<th>Metalloid Atom Diffusion Results</th>
<th>Metal Atom Diffusion</th>
<th>Metal Atom Diffusion Results</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Case 9</strong></td>
<td>Yes</td>
<td>Vacancy</td>
<td>Annih. at Surface 1</td>
<td>Vacancy</td>
<td>Annih. at Surface 2</td>
</tr>
<tr>
<td>Surface 1</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td><strong>Case 10</strong></td>
<td>No</td>
<td>Vacancy &amp; Interstitial</td>
<td>Annih. Internally in crystal</td>
<td>None</td>
<td></td>
</tr>
<tr>
<td>Surface 1</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td><strong>Case 11</strong></td>
<td>Yes</td>
<td>None</td>
<td>--</td>
<td>Vacancy &amp; Interst.</td>
<td>Annih. internally</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td><strong>Case 12</strong></td>
<td>Yes</td>
<td>Interst.</td>
<td>Removed at Surface 2</td>
<td>Interst.</td>
<td>Annih. at Surface 1</td>
</tr>
<tr>
<td>Surface 1</td>
<td>None</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

15. Reconsideration of all Cases Under a Real Metal Partial Pressure on Surface 2.

In all cases, the assumption is that the same defect will occur when the low $X_2$ partial pressure $(P_{X_2})_2$ is replaced by the
equivalent \((P_M)^2\) partial pressure by the following equations:

\[
M \, X_b \rightarrow a \, M(g) + (X_2)^b
\]  

therefore

\[
P_M = K \frac{a \, X_b \, P_{X_2}}{b/2\, a}
\]

Case 1. In this case the cation interstitials are formed on surface 2 but now instead of the destruction of unit cells on surface 2 they remain intact. The metals atoms from the vapor become the interstitial atoms instead of metal atoms from the crystal unit cells. In this case etching of the surface does not occur.

The original crystal becomes larger by growing on the high \(X_2\) pressure surface.

Case 2. In this case the metal vacancies formed on the high \(X_2\) pressure surface are just annihilated at the metal partial pressure surface by a metal atom from the gas replacing the metal atom on a surface unit cell. The crystal growth occurs on the high metalloid partial pressure surface.

Case 3. In this case the metalloid interstitials are formed on the high partial pressure surface, diffuse through the crystal and by combining with the gaseous or adsorbed metal atoms form unit cells on the metal partial pressure surface. Thus the crystal grows on the metal partial pressure surface. This is an independent check for metalloid interstitials.

Case 4. In this case the metal partial pressure forms metalloid vacancies by forming unit cells on the surface and the crystal grows on this surface. This diffusion of oxygen vacancies to the high \(X_2\) partial pressure surface will result in annihilation of oxygen vacancies by adsorbed \(X\) atoms on the high \(X_2\) partial pressure surface.
Thus Case 3 and 4 will result in crystal growth on the metal partial pressure surface and Case 1 and 2 will not result in crystal growth on the metalloid partial pressure surface. In the prior considerations whereby a low partial pressure of $X_2$ was used, crystal growth occurred for Case 1 and Case 2 but not for Case 3 and Case 4.

**Case 9.** In this case the crystal grows on both surfaces, the surface 2 side of the vacancy disk remains at a constant $X_0$, and the surface 1 side of the vacancy disk recedes towards $x = 0$.

**Case 10.** In this case the crystal only grows on the metal partial pressure surface and $X_i$ imperfections annihilate $V_x$ imperfections within the crystal by association.

**Case 11.** In this case the crystal grows only on the metalloid partial pressure surface and $M_i$ imperfections annihilate $V_M$ imperfections within the crystal by association.

**Case 12.** In this case the crystal does not grow unless the $X_i$ imperfections can diffuse thru the portion of the crystal having an excess of $M_i$ imperfections. If the respective imperfection are uncharged they are likely to do this. In this stance both surfaces will grow. Since the defects may be ionized then defect-defect interactions will occur and halt diffusion. A comparison of using different vapors is summarized in Table 4.

16. **Discussion of the Determination of Defects**

The determination of the type of defect is independent of the form of the crystal. That is, the membrane disk may be either polycrystalline or single crystal. There is little reason to believe that polycrystalline material would show a different type of defect than single crystal material under the same environmental conditions. The time required for diffusion results may be different because of the generally faster diffusion along grain boundaries.

The temperatures used would generally be above one half the melting temperature so that diffusion can proceed and surface reaction rates would be sufficiently fast. Temperatures very close to the melting point would be particularly interesting because the large
<table>
<thead>
<tr>
<th>Case</th>
<th>Growth on Surface 1</th>
<th>Growth on Surface 2</th>
<th>Diffusing Specie from Surface 1</th>
<th>Diffusion Specie from Surface 2</th>
<th>Internal Results of Diffusion</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>{P}_{X2}^2</td>
<td>Yes</td>
<td>No (etches)</td>
<td>-</td>
<td>{M}_1</td>
</tr>
<tr>
<td></td>
<td>{P}_{M}^2</td>
<td>Yes</td>
<td>No (non-etching)</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>2</td>
<td>{P}_{X2}^2</td>
<td>Yes</td>
<td>No (etches)</td>
<td>{V}_M</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td>{P}_{M}^2</td>
<td>Yes</td>
<td>No (non-etching)</td>
<td>{V}_M</td>
<td>-</td>
</tr>
<tr>
<td>3</td>
<td>{P}_{X2}^2</td>
<td>No</td>
<td>No</td>
<td>{X}_i</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td>{P}_{M}^2</td>
<td>No</td>
<td>Yes</td>
<td>{X}_i</td>
<td>-</td>
</tr>
<tr>
<td>4</td>
<td>{P}_{X2}^2</td>
<td>No</td>
<td>No</td>
<td>-</td>
<td>{V}_X</td>
</tr>
<tr>
<td></td>
<td>{P}_{M}^2</td>
<td>No</td>
<td>Yes</td>
<td>-</td>
<td>{V}_X</td>
</tr>
<tr>
<td>5</td>
<td>{P}_{X2}^2</td>
<td>Yes</td>
<td>No</td>
<td>{V}_M</td>
<td>{V}_X</td>
</tr>
<tr>
<td></td>
<td>{P}_{M}^2</td>
<td>Yes</td>
<td>Yes</td>
<td>{V}_M</td>
<td>{V}_X</td>
</tr>
<tr>
<td>6</td>
<td>{P}_{X2}^2</td>
<td>No</td>
<td>No</td>
<td>{X}_i</td>
<td>{V}_X</td>
</tr>
<tr>
<td></td>
<td>{P}_{M}^2</td>
<td>No</td>
<td>Yes</td>
<td>{X}_i</td>
<td>{V}_X</td>
</tr>
<tr>
<td>7</td>
<td>{P}_{X2}^2</td>
<td>Yes</td>
<td>No (etches)</td>
<td>{V}_M</td>
<td>{M}_1</td>
</tr>
<tr>
<td></td>
<td>{P}_{M}^2</td>
<td>Yes</td>
<td>No (non-etching)</td>
<td>{V}_M</td>
<td>{M}_1</td>
</tr>
<tr>
<td>8</td>
<td>{P}_{X2}^2</td>
<td>&quot;Yes&quot;</td>
<td>No</td>
<td>{X}_i</td>
<td>{M}_1</td>
</tr>
<tr>
<td></td>
<td>{P}_{M}^2</td>
<td>&quot;Yes&quot;</td>
<td>&quot;Yes&quot;</td>
<td>{X}_i</td>
<td>{M}_1</td>
</tr>
</tbody>
</table>
variation from stoichiometric netry that occurs at these temperatures. This experiment, unlike many others, will yield results at these temperatures. Various partial pressures can be used on either side of the membrane and the ability to vary these partial pressures form a very useful experimental tool. Either $P_{X_2}$ or $P_M$ may be used on surface 2. The partial pressure span may be large and include the stoichiometric partial pressure, or, be smaller and on either side of the stoichiometric pressure. The control of temperatures is another useful variable. Increasing the temperature is equivalent to changing the pressure through the law of mass action. Thus, a variation in results will occur in particular systems with a change in temperature.

The five assumptions (Page 3) on which this determination depends are valid in all ordered crystals including the intermetallics and the ordered metal alloys. When conduction is by ionic diffusion only ($t_e = 0$), the surfaces have to be electrically connected so that electronic conduction occurs externally between the metal partial pressure surface and the metalloid partial pressure surface.

The experimental apparatus would depend upon the temperatures needed, the type of metalloid gases needed, e.g., oxygen, sulfur, tellerium, antimony, selenium on the high and low $X_2$ pressure surfaces, and, if needed, the type of $M$ gases.

The ratio of the thickness to the diameter of the membrane should be sufficiently small so that one-dimensional diffusion will occur and the results will be simpler to interpret. One is not limited to this, however, for a three pressure gas system may be used as shown in Figure 4. The added possibilities with either metal or metalloid partial pressure are involved but the results can be determined by analysis similar to the prior discussion.

The determination of the type of defect is quite simple, (1) surface conditions are analyzed in regard to growth, and etching or nonetching conditions, (2) concentration gradients are determined, and (3) internal crystal conditions are examined. The use of the two different types of atmospheres on surface 2 provides an additional consistency check, as will the determination of the temperature gradient during the experiment. The monitoring of the quantities of gases used or reacted on either surface also will serve as a correlation to either the crystal growth or the permeability of the membrane to $X_2$.

The presence of impurities in the crystal will not effect this determination of the native imperfections. The presence of impurities extrinsically controls the concentration of defects over some partial pressure range. Thus, if the limit of partial pressure range can be exceeded in either direction the determination of defects will occur. The diffusion will take place since the concentration of defects
Figure 4. Three Pressure Gas Experiment

is intrinsically controlled by the atmosphere on one side, and extrinsically controlled on the other side by the impurities, thus yielding a concentration gradient. Determining which surface grows and the concentration gradient is the same as before.

It should be noted that the experiment results are because of the diffusion of all the ionized states of the imperfection, and all the self associated states of the imperfection, such as $(V_X V_X)$. The diffusion may be different from one another but a concentration gradient would exist for any of the associated defects. Thus, the determination is independent of the associations, this is a reflection of the elementary assumptions.

There may be crystal systems where two defects are present simultaneously on one surface such as $M_i$ and $V_X$ with $[V_X]^X > [M_i]^X$ but that $D_{M_i} > D_{V_X}$ so that $|j_{M_i}| > |j_{V_X}|$. This analysis shows that the surface with the greatest growth rate does not necessarily have to be associated with the defect having the highest concentration but in fact always represents that defect having the greatest $j = D \frac{dc}{dx}$. Thus it is always the most important defect in so far as mass transport is concerned. By using $D_{M_i}$ in this case the crystal would grow on both surfaces because of some diffusion of the $[V_X]$. 

29
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There may be crystal systems where \( \text{twc} \) defects are present
simultaneously on one surface such as \( M_i \) and \( V_X \) with
\( V_X > M_i \)
but that \( D_{M_i} > D_{V_X} \) so that \( j_{M_i} > j_{V_X} \). This analysis shows that the
surface with the greatest growth rate does not necessarily have to be
associated with the defect having the highest concentration but in fact
always represents that defect having the greatest \( j = \frac{dc}{dx} \). Thus it
is always the most important defect in so far as mass transport is con-
cerned. By using \( D_M \) in this case the crystal would grow on both sur-
faces because of some diffusion of the \( V_X \).
17. **Antistructure Disorder Determination.**

Antistructure disorder is believed to occur in those ordered systems where the size and electronegativity of the species is not appreciably different.

Antistructure disorder occurs when one species is in the normal lattice position of the other species as represented by

\[
\frac{M_X^x + X_X^x}{M_M^x + XM} = K(64)
\]

with its associated equilibrium constant

\[
\frac{[M_X^x][XM]}{[M_M^x][XM]} = K_A
\]

which is independent of the atmosphere.

Now, assume that (e.g.) a low partial pressure \(X_2\) (g) produces \(V_X\), and a membrane cell is used with the other surface a stoichiometric surface in regard to \(V_X, X, \gamma_M, M\), then growth of the membrane will occur because the \(V_X\) diffusion would bring \(M_X\) imperfections to the low partial pressure surface where they would form unit cells. Thus, the crystal could grow under a condition of metalloid vacancy diffusion that would not occur without antistructure disorder. Quantitative information as to the degree of antistructure disorder could be obtained if the other parameters are known by measuring the crystal growth.
The diffusion of $V_X$ species would result in a diffusion of $M$ atoms by the following relation

$$j_M = \frac{[M_X]}{[X_M]} j_{V_X} \tag{66}$$

but since

$$j_X = -j_{V_X}$$

$$j_M = -\frac{[M_X]}{[X_M]} j_X \tag{67}$$

Now the internal antistructure disordered will be maintained by

$$\left[ \frac{M^X}{X_M} \right] = K_A \tag{68}$$

and it is not evident at this time what atomic details will take place internally. There are several possibilities, such as the production of $V_M$ sites by the association of $X_M$ and $V_X$ sites, etc. Further consideration of other nonstoichiometry and antistructure disorder can be determined by the reader.

18. Nonstoichiometric Diffusion Etching by Low Partial Pressures of $X_2$.

The preparation of the surface plays an important role in the diffusion of titanium interstitials in titania. It was found that an optically polished surface greatly reduced the reaction rate of the formation and/or the diffusion of titanium interstitials and the regrowth on the high $O_2$ partial pressure side. Because of the similarity of the diffusion of titanium interstitials and lithium interstitials in TiO$_2$, the author favors the limitation of the diffusion into the crystal as the controlling factor. Johnson (Reference 14) reported that lithium
interstitials will not diffuse thru a polished surface. A polished surface is a work hardened surface in that many dislocation loops are formed. The dislocation loops penetrate the volume of the crystal only a few microns.

The reactivity at a dislocation penetrating the surface may be high but the diffusion of the titanium interstitials may be limited by the large number of intersecting dislocations. The size of the interstitial sites would be smaller in the compression region of the dislocations, the jump distance larger in the tension region, and the jump direction changed with the result that the diffusion may be greatly reduced and retarded.

If the work hardened surface is removed by chemical etching (fuming H₂SO₄) the intersecting dislocation region is removed so that only those dislocations that penetrate into the volume of the crystal for some distance are present. The rate of gaseous etching on the compression side of the dislocation would be larger because of the increased lattice energy. Interstitial diffusion along the dislocation into or in other directions away from the dislocation is now possible. However, there could very well be crystallographic surfaces where the surface reaction rates and diffusion of interstitials from this surface are sufficiently fast that etching may occur predominantly on these surfaces. Both of these possibilities are apparent in the experimental results.

Nonstoichiometric diffusion etching using low-vapor pressure of the X₂ gas has been shown experimentally to produce unusual tunneling. An explanation of this is in order. Consider Figure 5, which represents a single crystal membrane. Consider that for some reason a local area initially reduces faster by the production of metal interstitials. The metal interstitials diffuse in all directions from this local region leaving a small depression. At some distance away, another similar area produces a small depression. The increase in the concentration of metal interstitials in the area between these two depressions will occur by diffusion from the depression regions. As this process continues the iso-nonstoichiometric diffusion concentrations (INDC) will have equal concentrative surfaces depicted by the dashed lines in Figure 5.

The regions of highest concentration gradients and therefore, greatest diffusion will be immediately below the depression areas. The surface between the two depressions will tend to arrive at a nonstoichiometric equilibrium, not because of its own surface.
Figure 5. Production of Channels or Tunnels by Nonstoichiometric Diffusion.

reduction, but from defect diffusion produced at the depression. Thus, the continuation of the process leads to nonstoichiometric diffusion channels or tunnels.
18. **Interacting and Noninteracting Cases**

In order to develop the low partial pressures of metalloid associated with the crystal without resorting to ultra-vacuum techniques, it is necessary to use gases with very low equilibrium partial pressure of the metalloid. Cases involving $H_2/H_2O$ and $CO/CO_2$ are normally used for the oxides. If the gas is a noninteracting gas, the equilibrium between the solid and the gas need only consider the solid surface-gas relationship. However, the influence of an interacting gas may result in a foreign atom impurity doping reaction.

The $H_2/H_2O$ system should be considered with great care because of the small size of the ion (i.e., a proton) and its fast interstitial diffusion in many systems. The partial pressure of the oxygen can be determined by the reaction

\[ H_2O (g) \rightleftharpoons H_2 (\text{gas}) + 1/2 O_2 (g) \]  

(69)

with its associated equilibrium Equation

\[ \frac{P_{H_2}}{P_{O_2}^{1/2}} \cdot P_{H_2O} = K_{H_2O} \]  

(70)

This will determine at any temperature the partial pressure of $O_2(g)$, if $P_{H_2}/P_{H_2O}$ is known. However, this may not be the important reaction. The $H_2(g)$ may interact with the crystal as follows (using TiO$_2$ as an example)

1. \[ 1/2 H_2 (g) + Ti^4 \cdot + ZO'' \rightleftharpoons H_i^1 + Ti^3 \cdot + 2O'' \]  

(71)

2. \[ 1/2 H_2 (g) + Ti^4 \cdot + 2O'' \rightleftharpoons H_i^1 + Ti^4 \cdot + 2O'' + \text{e}' \]  

(72)

3. \[ 1/2 H_2 (g) + Ti^4 \cdot + 2O'' \rightleftharpoons H_i^1 + Ti^4 \cdot + 2O'' \]  

(73)

(\sim) \[ H_2 (g) + Ti^4 \cdot + 2O'' + 1/2 O_2 (g) \rightleftharpoons 2H_i^1 + Ti^4 \cdot + 3O'' \]  

(74)
(5) \[ 4H_2(g) + Ti^{4+} + 2O'' \rightleftharpoons 2H_2O(g) + Ti^{2+} \] (75)

or

\[ 4H_2(g) + Ti^{4+} + 2O'' \rightleftharpoons 2H_2O(g) + Ti^{2+} + ne' \]

(6) \[ H_2(g) + 2Ti^{4+} + 4O'' \rightleftharpoons H_2O + 2Ti^{3+} + 3O'' \] (76)

(7) \[ H_2(g) + Ti^{4+} + 2O'' \rightleftharpoons H_2O + Ti^{4+} + O'' + V_o + 2e' \] (77)

$H_2/H_2O$ gas mixture enriched with deuterium have resulted in optical absorptions bands that can be associated with $H_1$ and $D_1$ foreign impurity imperfections (Reference 15). Hydrogen reduced TiO$_2$ is also known to be an n-type conductor (Reference 16) and loses weight. Using these experimental facts, reactions, 71, 72, 73, or 74 are possibly occurring with the conclusion that hydrogen may be an interacting gas.

For CO/CO$_2$ the following reactions occur

(1) \[ CO_2 \rightleftharpoons CO + 1/2 O_2 \] (78)

(2) \[ CO \rightleftharpoons C + 1/2 O_2 \] (79)

with an associated equilibrium constant for reaction 79 extremely low. The likelihood of the CO molecule becoming an imperfection in TiO$_2$ is unlikely from an energy standpoint. Thus, the CO/CO$_2$ gas equilibrium with TiO$_2$ can be considered by the following reactions

(1) \[ CO_2 \rightleftharpoons CO + 1/2 O_2 \] (80)

(2) \[ Ti^{4+}_i + 2O'' + 2CO \rightleftharpoons Ti^{n+}_i + 2CO_2 + ne' \] (81)

or

(3) \[ Ti^{4+}_i + 2O'' \rightleftharpoons Ti^{n+}_i + O_2(g) + ne' \] (82)

where the oxygen partial pressure is controlled by reaction 82. Thus, CO/CO$_2$ gas can be considered a noninteracting gas.
B. ENDOTAXY - CRYSTAL GROWTH

The growth of reasonable size crystals of ultra-high purity with low dislocation count is extremely important from a research standpoint. The researcher can then discern through experiment the intrinsic characteristics of the crystal. The purification of silicon and germanium is an excellent example of this. Many meaningful experiments have been accomplished since the advent of these pure elemental semiconductors that would have been worthless otherwise. For this reason, it seems valuable to make some comment regarding endotaxy (endo-within and taxios-arrangement). The discussion will include the implications of crystal growth theories, means of purification, and means of removing line and surface defects.

The methods presently employed in growing single crystals can be classified into three groups as follows:

1. Growth from the vapor phase
   a. Sublimation
   b. Reaction in the vapor phase
   c. Thermal decomposition
   d. Disproportionation

2. Growth from the liquid phase
   a. Growth from the melt
      1. Directional freezing
      2. Crystal pulling
      3. Zone melting
      4. Pedestal pulling
      5. Tip fusion
   b. Growth from an alloy
c. Growth from solvents (molten salts)

d. Growth from liquid solutions (water, alcohol,

3. Growth from the solid phase

a. Recrystallization

b. Solid state reaction

c. Growth by tarnishing reaction

The nearest method to endotaxial crystal growth is item 3c. This has an advantage of initially forming a single crystal (usually a thin membrane) if a metal single crystal is used. However, this has severe limitations. The transition from a defect experiment to crystal growing is relatively simple. The temperature is raised, the crystal membrane is oriented, and the partial pressures using $(PM)_2$ are adjusted to give the highest rate of growth consistent with quality.

The method of arrival at the endotaxial growing surface of the atomic species involved is drastically different than the present crystal growth techniques. One of the two atomic species is already chemically combined with crystal. In the case of metal atom interstitials they will be ionized to some extent, and as they arrive on the surface will chemically react with the stoichiometric number of metalloid atoms. Thus, the type and number of ionic and covalent bonds to be formed are different.

In the ideal membrane, the diffusion of (e.g.) the interstitial species would be uniform over all areas. Thus, the entire growing surface will have a uniform distribution of new atoms arriving by interstitial or interstitialcy diffusion of the metal species. A fundamental question now emerges. Is it necessary to have screw dislocations for crystal growth by this method? The answer to this question may have fundamental significance. The number of chemisorbed adsorbed metalloid atoms on the growing surface versus the number of arriving interstitials is another parameter. The surface mobility of the arrived metal atom is still another parameter. Unlike growth from the vapor phase, the chemical formation of a unit cell has to occur on the surface (the metal vapor pressure is necessarily small because of the high metalloid vapor pressure). Crystallographic
orientation can be controlled by the seed crystal for the optimum growing surface. When the stoichiometric partial pressure can be spanned, the crystal can be grown on either surface as in Case 12. If \( (P_{X_1})_1 > (P_{Y_1})_2 > (P_{X_2})_2 \) or \( (P_{X_2})_1 > (P_{X_1})_2 > (P_{X_2})_2 \) then Case 1, 2, 3 or 4 may be used for growth. The difference in the growth by having intermetallic atoms arriving on surface 2, versus, the growth by having metal atoms arriving on surface 1, will be most interesting and enlightening. The variation of the partial pressures and temperatures leads to great versatility. In fact, electric fields may be used to enhance the diffusion of ionized interstitials.

The rate of growth will, in general, be slower than most other crystal growing techniques. However, in almost all crystal growing techniques the perfection of the crystal is inversely proportional to the rate of growth. From a research standpoint the rate of growth is not important, but the mere ability to grow and acquire a high perfection crystal is important. If application of a crystal device requires high perfection, then the rate of growth is important as reflected by the cost. Each crystal growing technique has its own type of crystals which can be grown. The introduction of a new technique such as endotaxy and the investigation of this technique will likely yield certain crystals which can be grown larger and of higher purity and perfection than can be grown by any other technique.

As yet, there is no general consolidated theory for the growth of crystals. Thus, the investigation of a new technique will yield experimental data necessary for correlation with theory.

If surface reaction rates and electron transports are not controlling, the diffusion of the imperfections through the crystal will determine the rate of growth. The rate of growth can be determined by the following equations

\[
\frac{dx}{dt} = \frac{\Omega}{a} j_m \quad \text{for surface 1 growth} \tag{83}
\]

or

\[
\frac{dx}{dt} = \frac{\Omega}{b} j_X \quad \text{for surface 2 growth.} \tag{84}
\]

where \( dx \) is the increase in crystal thickness, \( \Omega \) is the unit cell volume, and \( j \) = No. of atoms/cm\(^2\) sec arriving at the growing surface by diffusion.

38
The rate of growth for constant environmental conditions is dependent upon the thickness of the crystal because of the decrease in concentration gradient with an increase in crystal thickness. A moving boundary condition differential equation has to be solved to determine the rate growth versus time. A reasonable approximation, however, and general discussion of technique is of importance here.

First, however, it is necessary to derive the meaning of the terms in Fick's Law and to show a clear picture of steady-state mass diffusion. Diffusion is an activated process. For example, if we consider the energy of an interstitial atom as it moves from one interstitial position to another in a diffusion jump, there is an intermediate position of high energy. This intermediate position of high energy is the activated complex. The activated complex in action rate theory can be treated as any other atomic species, and an equilibrium constant $K_{\text{act}}$ can be employed for the formation of this complex. The free energy of formation of the activated complex is related to the equilibrium constant by:

$$\Delta F = RT \ln K_{\text{act}} \quad (85)$$

According to the second fundamental assumption of reaction rate theory the rate of transition of the activated complex into a product is a universal constant equal to $\frac{kT}{h}$ where $k$ is Boltzmann's constant, $T$ is the absolute temperature and $h$ is Planck's constant ($\frac{kT}{h} = 2.1 \times 10^{10}$/sec.) The specific rate constant is

$$r = \frac{kT}{h} K_{\text{act}} \quad (86)$$

and the specific rate constant times the concentration gives the number of transitions/cm$^3$ sec.

Thus, at a plane where the concentration of interstitials is denoted by $C$, where the average pump distance is denoted by $\lambda^*$, and the fraction of sites in the forward direction is denoted by $1/m$, the flux of atoms in the forward direction

$$j_f = \frac{kT}{h} K_{\text{act}} C \frac{\lambda^*}{m} \quad (87)$$

where $\lambda^* = \frac{\sum \Lambda (\cos \alpha)}{2}$ (for a centrosymmetric crystal system) \quad (88)
The flux in the reverse direction at the plane \( x + \lambda^* \), if the concentration changes with distance, is

\[
J_r = \frac{kT}{h} K_{\text{act}} \frac{\lambda^*}{x} (C + \lambda^* \frac{dc}{dx}) \tag{89}
\]

The difference between these two equations is the net flux in the forward direction, or

\[
J = - \frac{kT}{h} \frac{\lambda^2}{m} K_{\text{act}} \frac{dc}{dx} \tag{90}
\]

Now

\[
K_{\text{act}} = e^{-\frac{\Delta H_{\text{act}}}{kT}} e^{\frac{\Delta S_{\text{act}}}{k}} \tag{91}
\]

where \( \Delta H_{\text{act}} \) and \( \Delta S_{\text{act}} \) are the enthalpies and entropies associated with the activated complex. Thus,

\[
j = -\frac{kT}{h} \left( \frac{\lambda^2}{m} \right) e^{-\frac{\Delta S_{\text{act}}}{k}} e^{-\frac{\Delta H_{\text{act}}}{kT}} \frac{dc}{dx} \tag{92}
\]

Since Fick's law is usually written

\[
j = -D \frac{dc}{dx} \tag{93}
\]

or

\[
j = -D_0 \frac{\Delta H}{kT} \frac{dc}{dx} \tag{94}
\]

it is clear that

\[
D_0 = \frac{kT}{h} \frac{\lambda^2}{m} e^{-\frac{\Delta S_{\text{act}}}{k}} \tag{95}
\]

then

\[
\Delta H = \Delta H_{\text{act}} \tag{96}
\]

The prime purpose of this derivation is to point out that if the concentration gradients of diffusing species is already present in the
crystal, the entropies and enthalpies involved in $D$ are only those associated with the activated complex for motion. This is in marked contrast to the value for $D$ in a tracer isotope experiment where vacancy diffusion is involved. In tracer isotope diffusion by vacancies the fraction site has to be changed from $\frac{1}{m}$ to $\frac{V_{S,F}}{m}$, where, $V_{S,F}$ is the vacancy site fraction or the probability that the $\frac{1}{m}$ site is vacant. $V_{S,F} = \frac{[V_m]}{n}$, where, $[V_m]$ is the concentration/cm$^3$ of vacant sites, and $n$ is the concentration/cm$^3$ of $M$ sites. For example, a Frenkel type defect

$$V_{S,F} = \frac{A}{n} e^{2kT}$$

(97)

Since, in a tracer diffusion experiment one looks at the tracer atoms, the $\frac{dc}{dx}$ term is the concentration gradient of tracer atoms. However, in a steady-state mass diffusion experiment one looks at the diffusion of the vacancies or interstitials themselves, the site fraction factor remains essentially $\frac{1}{ln}$ (actually it is $\frac{[M_m]}{[V_m]} \approx \frac{1}{m}$ for mass diffusion of vacancies) and

$$j = \frac{kT}{h} \frac{\lambda^2}{m} e^{\frac{\Delta S_{act}}{k}} - \frac{\Delta H_{act}}{kT} \frac{dc}{dx} = D_o e^{\frac{-\Delta H_{act}}{kT} \frac{dc}{dx}}$$

(98)

where $C$ is the concentration gradient of imperfections.

It is now interesting to look at some numbers to see if endotaxial growth is practical. By substituting $98$ in $93$ one gets

$$(a = 1)$$

$$\frac{dx}{dt} = \Omega D_o e^{\frac{\Delta c}{kT} \frac{\Delta x}{\Delta x}}$$

(99)
Some reasonable numbers are

\[ \Omega = 40 \times 10^{-24} \text{ cm}^3 \]
\[ D_c = 5 \times 10^{-2} \]
\[ \Delta H_{\text{act}} = 0.5 \text{ ev for motion} \]
\[ \Delta c = 5 \times 10^{19}/\text{cm}^3 \]
\[ \Delta x = 0.5 \text{ cm} \]

which are probable at high temperatures. This yields

\[ \frac{dx}{dt} \sim 400 \text{A/sec at 1200C} \]

(100)

This means that in a day \( 400 \times 10^{-8} \times 8.6 \times 4 = 0.344 \text{ cm/day} \), or in \( 3 \) days a 1 cm thick crystal can be grown. This is, in fact, probably too fast if high quality is desired.

A crystal of high quality would have a low foreign impurity concentration, and a small number of dislocations per cm².

1. Purification and Growth of High Purity Crystals.

Let us first consider the problem of impurities in the seed crystal. Impurities are either substitutional or interstitial. Consider only metallic impurities and growth by an interstitial mechanism.

A concentration gradient of the host crystal cation interstitials will be driving the diffusion. It is easily seen that the foreign ion interstitials also will be driven out of the crystal. This is true because the interstitial site fraction in the rearward direction will be reduced when the host cation interstitial arrives at jump site immediately behind foreign ion interstitial. Thus, the probability for a rearward direction diffusion jump is decreased with the result that the impurities are driven out of the crystal. If the foreign ion is a substitutional ion and the interstitialcy mechanisms predominates, the substitutional sites will be emptied (if the binding energy is lower than the host atom). If the cation vacancy is the imperfection causing the
crystal growth, then purification will occur. If \( D_F < D_H \), where \( D_F \) is the diffusivity of the foreign species, and \( D_H \) is the diffusivity of the host species, the crystal will have a higher concentration of foreign ion near the growing surface. If \( D_F > D_H \), then the crystal will be purer near the growing surface. By the use of zone-refined metals for the metal vapor pressure the addition of foreign impurities can be kept to a low value. By using a thin membrane the concentration of foreign impurities is reduced by an order of magnitude if the thickness is increased by a factor of 10, even if the initial impurities act as a completely soluble species. The production of five to six nines purity crystals appears easily available. The next problem concerns the dislocation concentration.

2. Dislocation Climb

The ability to grow crystals and the purification techniques leads one to the question as to whether or not the line imperfections can be removed from a crystal. The two types of line imperfections, i.e., edge dislocations and screw dislocations, have different properties and must be considered separately.

An edge dislocation has a region of compression in the extra half plane and a region of tension on the other side of the dislocation line. Interstitial ions can reduce the energy associated with the dislocation by diffusing into the region of tension. Substitutional ions of larger size than the substituted ion also tend to move towards the region under tension to relieve the strain energy. Similarly, vacancies and smaller substitutional ions move toward the region of compression. Thus, dislocations tend to cluster foreign impurities. However, the motion of native imperfections to the dislocation will cause the dislocation to climb. The extra half plane is usually considered to be stoichiometric in a polyatomic crystal. Therefore, for climb to occur, all atomic species must diffuse to or from the dislocation for negative or positive climb. (Negative climb occurs when the extra half plane increases in area.)

Now, consider Case 10 and Case 11 of Table 2. As described in the discussion of Case 10, there is a stoichiometry plane in the interior of the crystal where the concentration of metal and metalloid vacancies has the stoichiometric ratio. As pointed out, these vacancies will tend to associate, but they also will be driven either singly, or, as an associated defect towards the region of compression associated with the dislocation. Thus, dislocation climb will occur, but since the climb can only continue to occur as long as all vacancy species move...
Towards the dislocation, the rate of dislocation climb will decrease the further the dislocation climbs away from the stoichiometric plane. Thus, the proper thing to do is to move the stoichiometric plane through the crystal at the rate the dislocation climb. The position of the stoichiometric plane can be controlled by the relative partial pressures in association with the diffusion constants. Consider Figure 6.

Figure 6. Stoichiometric Plane at \( x = x' \)

Both vacancies will diffuse toward \( x' \) according to their respective equations.

\[
\begin{align*}
    j_{V_M} &= -D_{V_M} \frac{d}{dx} \left[V_M\right] \\
    j_{V_X} &= -D_{V_X} \frac{d}{dx} \left[V_X\right]
\end{align*}
\]  \hspace{1cm} (101)

A good approximation for \( d \left[V_M\right] \) if \( \left[V_M\right]_x = 0 \rightleftharpoons \left[V_M\right]_x = x', \) is \( d \left[V_M\right]_x = \left[V_M\right]_x = x' - \left[V_M\right]_x = 0 \approx -\left[V_M\right]_x. \) Similarly, a good approximation for \( dV_X \approx +\left[V_X\right]_x = x' \)

Therefore, the two equations become

\[
\begin{align*}
    j_{V_M} &= -D_{V_M} \frac{d}{dx} \left[V_M\right]_x = 0 = D_{V_M} \frac{\left[V_M\right]_x = 0}{x'} \\
    j_{V_X} &= -D_{V_X} \frac{d}{dx} \left[V_X\right]_x = 0 = D_{V_X} \frac{\left[V_X\right]_x = 0}{x'}
\end{align*}
\]  \hspace{1cm} (103)
The condition for stoichiometry at plane $x'$ is that the number of vacancies arriving is in the stoichiometric ratio or that,

$$\frac{j_{V,M}}{j_{V,X}} = \frac{a}{b}$$  \hspace{1cm} (105)

Now, combining Equations 103, 104, and 105 and solving for $x'$, one obtains,

$$x' = \frac{\frac{1}{D_{V,X}} \left| \frac{V_X}{V_M} \right| f}{1 + \frac{a}{b} D_{V,M} \left| \frac{V_M}{V_M} \right| 0}$$  \hspace{1cm} (106)

Now $x'$ can be made small by $\left| \frac{V_X}{V_M} \right| 2$ being large. This can be accomplished by having $(p_{X_{2,1}}) = (p_{X_{2,2}})$ and $(p_{X_{1,2}}) < (p_{X_{2,2}})$; therefore, $\left| \frac{V_M}{V_M} \right| -0$.

$x'$ also can be made large by having $(p_{X_{2,2}}) = (p_{X_{1,2}})$ and $(p_{X_{2,1}}) > (p_{X_{2,2}})$; therefore, the denominator approaches 1.

In other words, one could start with $(p_{X_{2,1}}) = (p_{X_{2,2}})$ and increase in pressure while $(p_{X_{2,2}})$ (which was initially much less than $(p_{X_{2,2}})$ ) approaches $(p_{X_{2,2}})$. Now, to sweep out both positive and negative edge dislocations (with respect to $-$) would require a reverse
sweep of the stoichiometric plane. By geometrical arguments one can see that any edge dislocation having any orientation would be swept out of the crystal by this method.

Case 11 is the condition where metal and metalloid interstitials move from the surfaces towards the internal stoichiometric plane. In this case, the dislocations would undergo negative climb, i.e., the half plane would grow. Similar equations can be derived for the position of the stoichiometric plane and its position controlled by the relative pressures on either side of the boundary.

The motion of a screw dislocation is always glide. A force causing it to glide is not immediately apparent. However, an immediate effect one can visualize by the following arguments. The elastic energy of a screw dislocation is associated with the shear stress and varies as $b/r$ times a periodic function of $\theta$ where $b$ is the Burgers vector and $r, \theta$ are cylinder coordinates. The elastic energy could be reduced by the stoichiometric association of vacancies of both kinds in the region of small $r$. This would amount to the formation of a hollow cylindrical tube the center of which would be the position of the original screw. The size of this hole would be determined by the increase in the surface free energy in relation to the reduction in the elastic energy.

Grain boundaries on surface defects could climb out of the crystal in either Case 10 or Case 11 in the same manner as edge dislocations.
III. EXPERIMENTAL PROCEDURE

A. EXPERIMENTAL APPARATUS

The diffusion experimental apparatus was designed to hold a thin \( \pm 1 \text{mm} \) crystal disk sample between two different atmospheres at elevated temperatures. Thermocouples were placed on either side of the sample and the oxygen atmosphere was monitored by a precision volume measuring U-tube. Provision was made to hold the oxygen volume reservoir at controlled temperatures (by a liquid bath). The furnace was controlled by a centrally located Pt-Pt-13 percent Rh thermocouple placed in close proximity to the furnace winding. A Leeds and Northrup precision set point control unit controlled a 3 kW saturable reactor.

The gases used were Matheson's High Purity grade \( \text{O}_2 \), \( \text{CO} \), \( \text{H}_2 \), Argon and Linde's \( \text{CO}_2 \). The gas-flow rates were controlled by calibrated Matheson flow meters. The specimens were oriented by X-ray back reflection techniques and sliced with a diamond saw precision wafering machine. The specimens were then ground and polished by conventional optical lapping techniques to size (flat and parallel to less than four fringes) and then ground to a circular shape in a special lathe chuck.

Platinum washers were prepared from 9.9 mil sheet stock with a 0.750 in. OD and a 0.400 ID. The ceramic rings were cut and ground from high purity high density alumina plates to a thickness of 0.0 to 0.2 mil thinner than the specimens with a 0.750 OD and a 0.625 ID. The specimens were then placed inside the ceramic ring and two platinum washers were then placed on either side. This arrangement was then loaded between the two alumina atmosphere containing tubes and then the furnace was lowered into place.

The polycrystalline samples were prepared from Research Organic 99.99 percent pure TiO\(_2\) powder. Polyvinyl alcohol was used as a binder. The mixture was then dried and formed into a boule and hydrostatically compressed inside a balloon with 20,000 lb/sq in., in a pressure vessel. The formed boule was then heated at 300\(^\circ\)C for 48 hours and then slowly brought up to 1250\(^\circ\)C in a helium atmosphere and allowed to sinter to 94.5 percent theoretical density for 72 hours. The sample disks were then prepared in the usual manner.
Weight loss measurements were performed by reducing the sample in a controlled atmosphere and quenching in an inert atmosphere as shown in Figures 7 and 8. The samples were then weighed on a Mettler precision microgram balance, reoxidized in a 1 atm $O_2$ atmosphere, and reweighed.

The outer tube served to contain the controlled atmosphere and was surrounded by the furnace winding. The inner pedestal tube held a polished sapphire disk which served as the sample dish. An approximately 1 gram cubically cut TiO$_2$ single crystal was then placed on the dish and allowed to achieve equilibrium with the atmosphere. The tube was then lowered rapidly into the lower chamber which contained the inert atmosphere for quenching.
Figure 7. Details of Sample Holder Showing Growth of the TiO$_2$ Disk
Figure 8. Furnace Modification for Nonstoichiometry Determination
IV. EXPERIMENTAL PROGRAM

The experimental program was divided into two parts.

(1) To determine either the oxygen diffusion due to oxygen vacancies or to determine the titanium interstitial diffusion effects.

(2) To determine if consistent weight loss measurements could be made by reduction, quenching and then weighing procedures.

The initial diffusion experiment resulted in crystal regrowth on the high pressure surface. The work then proceeded to determine the following:

(1) What experimental results would be obtained by using a polycrystalline disk?

(2) What experimental results would be obtained by using single crystal disks having (100) faces and (001) faces?

(3) What experimental results would be obtained by using $\text{H}_2/\text{H}_2\text{O}$, $\text{CO/CO}_2$ atmospheres, and a $10^{-2}$ TORR partial pressure of $\text{O}_2$ on surface 2?

(4) What experimental results would be obtained by varying the surface preparation?

(5) What experimental results would be obtained by using Fe as a diffusing species?

A. POLYCRYSTALLINE MEMBRANE

Polycrystalline samples of 94.2 percent theoretical density were prepared and polished flat to within 2 to 4 fringes. The sample thickness was 0.76mm. The alumina ceramic ring was prepared to a thickness 0.000 to 0.005 mm thinner than the sample. The platinum seals were then placed on both sides and the arrangement placed
between the ceramic tubes inside the furnace. A CO/CO₂ gas ratio equal to one and pure O₂ were used on either side. Both gases were at one atmosphere pressure.

An initial run at 1000°C for four hours led to nonstoichiometric diffusion etching on the CO/CO₂ surface. No growth was visible on the O₂ surface. However, a cross-section revealed that densification was occurring in the center of the membrane. A second sample was then run for 32 hours at 1100°C. Densification and growth to and beyond the original O₂ surface occurred.

Figures 9 and 10 are photographs of the unpolished sample cross-section. Figures 11 and 12 are photographs of the polished cross-sections of the sample. Figure 13 reveals the densification occurring in the sample. Figures 14 and 15 are photographs of the O₂ surface. Figure 16 is a photograph of the CO/CO₂ surface.

Figure 9 is particularly interesting. The platinum seal serves as a marker. The regrowth is beyond the original surface which would be a line drawn between the inner edges of the platinum seal through the regrowth region. Upon cooling from 1100°C, the platinum contracts more than the oxides because of the differences in the coefficients of expansion. For this reason, polishing has to be performed with great care due to the residual compressional stresses. The platinum seal is slightly distorted near the regrowth region for this reason. The platinum seal is always bonded to the TiO₂ on the oxygen side. The platinum seals are never bonded to the TiO₂ on the CO/CO₂ surface.

Five distinct regions exist in the membrane as a result of the nonstoichiometric diffusion gradients. These are depicted in the sketch of Figure 17.

Region one is an area of regrowth beyond the original surface. Region two is an area of densification of the polycrystalline material. The difference in thickness of this region probably reflects local variations in original density. Region three is an area of densification under the platinum seal extending up the inside surface of the ceramic seal. Region four is an area essentially unscathed. Region five is a "scale" area that separated from Region two due to the dynamics of the diffusion.
Figure 9. Polycrystalline Unpolished Cross Section

Figure 10. Polycrystalline Unpolished Cross Section
Figure 11. Polycrystalline Polished Cross Section. Center Portion of Sample Shown in Figure 10 (X 14.5)

Figure 12. Polycrystalline Polished Cross Section of Sample Section Shown in Figure 9 (X 7.25)
Figure 13. Enlargement of Figure 12 Cross Section (X 94.3)

Figure 14. Polycrystalline High Partial Pressure O₂ Surface (X 10)
Figure 15. Enlargement of Figure 14—O\textsubscript{2} Surface (X 67.5)

Figure 16. Polycrystalline Sample—CO/CO\textsubscript{2} Surface (X 70)
Figure 17. Sketch Depicting Various Regions of Diffusion Results

The dynamics of the diffusion and regrowth is considered to take place as follows. The polycrystalline sample is impervious to gaseous flow. However, a 5.8 percent void volume is present. The CO/CO$_2$ surface is not microscopically flat due to the intersection of voids. This microscopically uneven surface approaches non-stoichiometric equilibrium with the CO/CO$_2$ atmosphere. Consider Figure 18 depicting the upper surface with intersecting voids.

Iso-nonstoichiometric concentration lines (INCL) are depicted by the dashed lines in Figure 18. A microcrystal such as A in Figure 18 will tend towards a uniform nonstoichiometric concentration because of the solid gas reaction on all of its surfaces. However, the nonstoichiometric gradients are causing diffusion of the imperfection specie. Therefore, the iso-nonstoichiometric concentration lines would
be separated by greater distances near the actual macroscopic surface. The INCL's would tend toward a straight line in the interior of the sample. The INCL's would be closer together in the region just below the lowest point of the surface void. The diffusion of the nonstoichiometric species would therefore be greatest in this region. This would tend to lower and widen the lowest point of the surface void even further because of removal of unit cells by titanium interstitial diffusion and evolution of $O_2$. This process continues reaching new voids. The widening continues until the Region 5 is separated from the membrane. At this time, Region 5 is at a uniform nonstoichiometric composition and no diffusion occurs. Titanium interstitial concentration gradients now exist in Region 2. Consider Figure 19 depicting the INCL's in a Region 2 with a void.

The INCL's closer to the CO/CO$_2$ Region 2 surface represent a higher concentration of titanium interstitials intersecting the void.
Figure 19. INCL's in Region 2 With a Void

Equilibrium tends to exist within the void, that is, every portion of the interior void surface, if no concentration gradients exist, would be in equilibrium with the void gas according to the following reaction.

\[ \text{TiO}_2 \rightleftharpoons \text{Ti}^{4+} + \text{O}_2(g) \]  \hspace{1cm} (107)

However, a concentration gradient of Ti exists. The upper void surface has a higher concentration of Ti than the lower void surface. The upper portion of the void surface therefore reacts with the \( \text{O}_2(g) \) within the void driving the reaction from right to left. Therefore, the interior upper surface moves toward the outer \( \text{O}_2 \) gas reservoir. However, since the \( \text{PO}_2 \) within the void is now lowered by this reaction, the lower portion of the void is now supplying the \( \text{O}_2 \) from unit cells on its surface. The entire void therefore moves toward the \( \text{O}_2 \) gas reservoir.

This effect is clearly seen in Figure 13. There are fewer voids near the \( \text{CO}/\text{CO}_2 \) reservoir than near the \( \text{O}_2 \) reservoir. Figure 20 is a photograph of Region 1, and the interface with Region 2 under
Figure 20. Enlarged Cross Section of Figure 12 Under Varying Illumination Conditions (X 91)
varying illumination. The dynamics at the O₂ surface with the arriving of titanium interstitials is the inverse of what happens on the CO/CO₂ surface. That is, the surface voids fill up first and then crystalline growth continues in Region 1. This line of demarcation between Region 1 and Region 2 is clearly seen in Figures 10, 11, 12 and 20. The interface between Region 1 and Region 2 has microcrystals up to 200 microns across versus an initial 5 to 10 micron particle size.

Region 3 is an area of densification due to titanium interstitials forming unit cells by combining with oxygen available due to leaking seals.

Region 4 has no large defect concentration gradients and this region remains essentially intact.

B. a-Cut Crystals

Single crystal TiO₂ was machined and optically polished (to within 2-4 fringes) to a thickness of 0.61 mm. Ceramic rings were prepared with a thickness 0.000 to 0.005 mm thinner than the TiO₂ disks. The orientation is depicted in Figure 21.

The samples were chemically polished in fuming H₂SO₄ for a minimum of three hours to remove the work hardened surface. CO/CO₂ and O₂ gases were used.

Figure 21. a-Cut Crystal Orientation
The results of four samples are shown in Figures 22a, 23a, 24a, and 25a. Figures 22b, 23b, 24b, and 25b are photographs of O₂(g) surface. The samples were run at temperatures of 900 C, 1000 C, 1000 C, and 1100 C for 8, 6, 8 and 6 hours, respectively.

All samples show single crystal regrowth on the O₂ surface. All samples show nonstoichiometric diffusion etching in channels along the c-axis direction on the CO/CO₂ side. The regrowth of Figure 22a was determined by Laue X-ray techniques to be single crystal. Growth layers on this surface are nucleated in many positions and extend in the c-axis direction. The 1000 C samples show a slightly changed surface growth condition resulting in fewer nucleation steps and a smoother surface. This could be due to higher surface mobility and/or more uniform diffusion of titanium interstitials to the surface.

The photograph of the surface in Figure 25b shows lighter regions which proved to be voids between the original O₂ surface and the outer crystal growth. These voids were connected by nonstoichiometric diffusion etch tunnels to the CO/CO₂ surface.

Crystal growth occurred between the Al₂O₃ ceramic ring and the TiO₂ membrane disk as indicated in Figures 22b, 23b, 24b, and 25b. In general, this growth was more predominant along arcs of the outer perimeter that could be connected to the center exposed portion of the crystal by lines parallel to the c-axis. The interface at the Al₂O₃ ceramic ring was reddish in color indicating iron impurities. More will be said about this later. The original CO/CO₂ exposed surface showed more nonstoichiometric diffusion etching than those areas originally covered by the platinum seal.

Figure 25 shows very straight nonstoichiometric diffusion etched tunnels (under the partially covered CO/CO₂ surface) in the c-direction that are connected to the lowered center region, and therefore, exposed to the CO/CO₂ gas. Enlarged photographs of this tunneling in this sample are shown in Figures 26, 27 and 28. The tunnels in general have flat interior surfaces (the curvature of the tunnels is caused by a pin cushion effect in the optics). The surfaces are (110) as indicated in Figure 29.
Figure 22a. a-Cut Sample O$_2$ Surface (X 6.0)

Figure 22b. a-Cut Sample CO/CO$_2$ Surface (X 6.0)
Figure 23a. a-Cut Sample O₂ Surface (X 7.6)

Figure 23b. a-Cut Sample CO/CO₂ Surface (X 5.1)
Figure 24a. a-Cut Sample O\textsubscript{2} Surface (X 7.1)

Figure 24b. a-Cut Sample—CO/CO\textsubscript{2} Surface (X 5.1)
Figure 25a. a-Cut Sample $O_2$ Surface (X 7.6)

Figure 25b. a-Cut Sample CO/CO$_2$ Surface (X 5.6)
Figure 26. Enlarged Photograph of Tunneling in Sample Shown in Figure 25.

Figure 27. Enlarged Photograph of Tunneling in Sample Shown in Figure 25.
Figure 28. Enlarged Photograph of Tunneling of Sample Shown in Figure 25.

Figure 29. Geometry of Tunnels
The very end of the tunnel seems to be quite flat, having a (001) face and of somewhat smaller area than the tunnel cross-section area. Unusual tunneling was observed as shown in Figure 28 along changing axial directions.

Unusual tunneling sometimes occurred as shown by a very randomly oriented tunnel as shown in Figure 30. From the size and circular cross shape of this tunnel, it is apparently a nonstoichiometric diffusion etching of a screw dislocation. Tunnels similar to this have been observed to change their cross-sectional shape from circular to straight rectangular tunnels and then back to ever changing circular tunnels again. This is probably due to the dislocation changing from screw to edge to screw.

Great care had to be exercised during cross-sectioning and polishing to prevent further fracture of the samples. Typical cross cross-sectioning is shown in Figures 31 and 32 of the sample shown in Figure 24a and 24b. The regrowth region has grown above the 0.248 mm thick platinum marker. This sample was diffused at 1000 C for eight hours.

The sample shown in Figure 23a and 23b fractured in the process of sectioning but the fracture surface revealed a very interesting marker of the regrowth region. The fracture shows an interface line between the original surface and the regrowth region. This is indicated by arrows in Figure 33. This line does not continue across the entire fracture surface, indicating that regrowth is in regions of an integral extension of the crystal. This edge was tipped slightly and the optics focused deeper so that the nonstoichiometric diffusion etching is revealed. This is shown in Figure 34.

This etching is in the a-axis direction so that temperature differences produce different etching tunnels. The surface etching is along grooves in the c-axis direction to some interior layer and then become a-axis tunnels. The a-axis tunnels are not as straight and uniform in direction as the c-axis tunnels.

The cross-section of the 1100 C sample of Figure 25a and Figure 25b is shown in Figures 35 and 36. The original interface is indicated by the arrows. Heavy nonstoichiometric diffusion etching as expected by the higher temperature is apparent.
Figure 30. Randomly Oriented Tunnel.

Figure 31. Cross Section of Sample Shown in Figure 24.
Figure 32. Cross Section of Sample Shown in Figure 24 (X 15.2).

Figure 33. Cross Section of Sample Shown in Figure 23 (X 23).
Figure 34. Cross Section of Sample Shown in Figure 23 (X 12.3).

Figure 35. Cross Section of Sample Shown in Figure 25 (X 20.1).
Figure 36. Cross Section of Sample Shown in Figure 25 (X 20.1).
C. **c-AXIS CRYSTALS**

The crystals were oriented by X-ray techniques, machined and polished flat to within 2 to 4 fringes. The crystal membranes were oriented as shown in Figure 37.

The (001) crystal disk experiments were performed early in the program. The initial run was performed in one atmosphere of CO and one atmosphere of O\(_2\) at 1150°C for 96 hours on a 1-mm thick sample. The exposed region of the crystal showed regrowth to a distance 1.5 mm below the original O\(_2\) surface. Portions of the original CO exposed surface remained at the original level. Non-stoichiometric diffusion etching permeated the entire exposed region so that the sample was pervious to gas flow. X-ray analysis showed the crystallographic orientation to be predominantly c-axis. The sample showed a profusion of flat ribbon whiskers and circular whiskers.

The time and temperature was then reduced and Figures 38 and 39 are the result of a 1-mm sample exposed to CO and O\(_2\) atmospheres for 23.5 hours at 982°C. As in all cases, the O\(_2\) platinum seal is "bonded" to the sample and fracture of the original surface occurs when removal is attempted. Figure 40 shows a polished cross-section of this sample. This sample was not chemically etched in fuming H\(_2\)SO\(_4\) and large areas of the exposed surface remain intact as indicated in Figure 39. The area under the platinum seal is attacked, however, and the greater portion of the titanium interstitial diffused from this region. Figure 40 shows a polished cross-section of this sample showing variations in the nonstoichiometric diffusion etching.
Figure 38. c-Axis Sample—No Chemical Pre-etching O₂ Surface (X 7.75)

Figure 39. c-Axis Sample—No Chemical Pre-etching CO Surface (X 7.75)
An outer ceramic ring was not used in this experiment so that the crystal grew beyond the original diameter of the circular membrane. Thus, there was no chance that the crystalline regrowth occurred by surface diffusion from one surface to the other. The initial diffusion to the O₂ platinum seal results in some diffusion to the unexposed O₂ surface. Thus, the region around the inner edge of the platinum seal on the O₂ side has always shown greater regrowth. However, as soon as the platinum seals to the TiO₂ disk, the majority of the diffusion would be volume diffusion. The crescent or circular shape of the cross-sectional regrowth region is to be expected. The INCL would be in the form as shown in Figure 41.

Since the INCL's are closer together at Region 1 and Region 2, the crystal would grow faster due to an increased diffusion in this region. Thus, the center portion of the crystal more closely represents the true diffusivity across the sample. However, due to the nonstoichiometric diffusion etching, the distance across the sample becomes an unknown. As pointed out in the theoretical section, a real partial pressure of metal would eliminate this problem and nonstoichiometric diffusion parameters could be measured.
One c-cut sample was diffused by using a CO atmosphere on one side and a partial pressure of 20 microns $O_2$ produced by floor pump for 24 hours at 965°C. A cross-section of this sample is shown in Figure 42. The growth on the $O_2$ surface was predominantly single crystal with some polycrystalline formation on the outer layer of the regrowth surface which extended 0.11 mm below the original $O_2$ surface. The nonstoichiometric diffusion etching was quite uniform to a depth of 0.4 mm to 0.5 mm.

Figures 43 and 44 are cross-sections of a c-cut sample that contained either an aggregate of impurities near the CO surface or the surface had some foreign object which enhanced the surface reaction rate. The result was a nonstoichiometric diffused tunnel through the membrane which destroys the concentration gradients.

The appearance of a red coloration on all c-axis sample membranes on the outer $O_2$ surface of the regrowth region suggested iron impurity diffusion. A comparison emission spectographic analysis of material removed from the two surfaces by a diamond tipped tool was performed. The results are shown in Table 5.
Figure 42. Growth by Using CO and 20 TORR O\textsubscript{2} (X 16.5).

Figure 43. Cross Section of c-Cut Sample Showing Nonuniform Diffusion Tunnels (X 6.8).
Table 5. Emission Spectrographic Analysis of Material Removed From the Two Surfaces

<table>
<thead>
<tr>
<th></th>
<th>O₂ Surface</th>
<th>CO/CO₂ Surface</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Titanium - Major</td>
<td>Titanium - Major</td>
</tr>
<tr>
<td></td>
<td>%</td>
<td>%</td>
</tr>
<tr>
<td>Aluminum</td>
<td>&gt;0.001 - &lt;0.01</td>
<td>Aluminum</td>
</tr>
<tr>
<td>Copper</td>
<td>&gt;0.0001 - &lt;0.001</td>
<td>Copper</td>
</tr>
<tr>
<td>Calcium</td>
<td>&gt;0.0001 - &lt;0.001</td>
<td>Calcium</td>
</tr>
<tr>
<td>Iron</td>
<td>&gt;0.0005 - &lt;0.005</td>
<td>Not detected</td>
</tr>
<tr>
<td>Silver</td>
<td>&gt;0.0001 - &lt;0.001</td>
<td>Not detected</td>
</tr>
<tr>
<td>Magnesium</td>
<td>&gt;0.0002 - &lt;0.002</td>
<td>Not detected</td>
</tr>
</tbody>
</table>

No other metals detected.
Iron, silver and magnesium are thus removed from the crystal due to the titanium interstitial gradients. Cu, Ca and Al however, did not diffuse to the O₂ surface. By the argument presented in the theoretical section this strongly suggests that Fe, Ag and Mg are interstitial foreign impurities, whereas, Cu, Ca, and Al reside in substitutional positions.

The previous spectrographic analysis led to the conclusion that Fe, Ag, and Mg were interstitial. As an additional check to see if this diffusion was indeed occurring, a small amount of iron oxide was placed on the low partial pressure oxygen surface.

The entire process of nonstoichiometric diffusion is equivalent to the transport of oxygen across the membrane regardless of the nature of the defect. The steps are as follows:

Low partial pressure surface: \[ \text{TiO}_2 (p_2) \rightleftharpoons \text{Ti}^{3+}_{x} (p_2) + \text{O}_2 (p_2) \]

Volume Diffusion: \[ \text{Ti}^{3+}_{x} (p_2) \rightleftharpoons \text{Ti}^{3+}_{x} (p_1) \]

Electron Transport: \[ \text{ne}^- (\text{TiO}_2, p_2) \rightleftharpoons \text{ne}^- (\text{TiO}_2, p_1) \]

High partial pressure surface: \[ \text{ne}^- (\text{TiO}_2, p_1) + \text{Ti}^{3+}_{x} (p_1) + \text{O}_2 (p_1) \rightleftharpoons \text{TiO}_2 (p_1) \]

Net Process: \[ \text{TiO}_2 (p_2) + \text{O}_2 (p_1) \rightleftharpoons \text{TiO}_2 (p_1) + \text{O}_2 (p_1) \]

where \( \text{Ti}^{3+}_{x} \) can represent either \( \text{Ti}^{3+}_{x} \text{Ti}_i \) or \( \text{Ti}^{3+}_{x} \). In the first case diffusion would occur by vacancies in the titanium sublattice and in the second case by titanium interstitials. For the net process, the free energy change is

\[
\Delta F = RT \ln \frac{p_2}{p_1} + RT \ln \frac{a_{\text{TiO}_2 (p_1)}}{a_{\text{TiO}_2 (p_2)}}
\]

where \( a \) represents the activity. Unless defect-defect interactions lead to a large change in the activities, the first term in the above equation is much greater than the second. (Note: Therefore, galvanic cell measurements would not separate these parts of \( \Delta F \); and therefore,
no information can be gleaned from classical thermodynamics about the defect structure. Thus, atomic details have to be assumed to determine the nature of the defect as was done in the theoretical section.

If foreign metallic oxides were present on the low pressure surface, an identical set of transport equations could be written with Fe$_3$O$_4$ in place of the TiO$_2$, if the same iron oxide was formed on the high partial pressure oxygen surface.

However, as always, atomic details are outside the realm of classical thermodynamics. If the iron atoms become interstitial impurities the diffusion should be rapid (assuming Fe$_i$ -free energy of motion low), the iron should become interstitial first and then the titanium ions next ($\Delta F_{Fe_3O_4} > \Delta F_{TiO_2}$); thus the iron should be transported to the high partial pressure first. This would be determined by a short diffusion experiment. Also, since iron oxide produces a red color on the surface, it should serve as an indirect check for volume diffusion and surface mobility.

The results of this diffusion are shown in Figures 45 and 46 which are photographs of the high partial pressure O$_2$ surface and the low partial pressure O$_2$ surface after diffusion.

The diffusion took place at 1050°C for one-half hour under a CO/CO$_2$ ratio of one and one atm of O$_2$. The corresponding areas on the two surfaces are circled. A pit is produced on the low partial pressure surface opposite the deposition of iron oxide and some growth of TiO$_2$ on the high partial pressure surface. The smaller of the two circled areas indicates that even at low concentration of foreign impurities bulk diffusion of both Ti and Fe took place. In the larger of the two areas, iron titanate may have been formed because of the large iron concentration which could lead to other possibilities. Thus it is evident that volume diffusion of both the Fe and Ti did occur. Notice that the remainder of the surface did not show appreciable growth in this short diffusion time experiment.

1. Nonstoichiometric Diffusion Using H$_2$/H$_2$OGas

The nonstoichiometry produced by hydrogen reducing gases occurs at lower temperatures and is believed to form an O-H bond with an O$_2$. This could have an effect upon the diffusion of Ti$_4$ by lowering the concentration gradient because of a large number of H$_2$.  

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Figure 45. $O_2$ Surface of Fe Diffusion Sample (X 5, 65)

Figure 46. CO Surface of Fe Diffusion Sample (X 5, 65).
Two experiments were performed using $H_2/H_2O = 10^6$ and $O_2$ on either side of the c-cut membrane. Figure 47a and 47b show the $O_2$ and the $H_2/H_2O$ surfaces, respectively. A polished cross-section is shown in Figure 48.

This diffusion was performed at 885°C for 4-1/6 hours. The entire character of the diffusion has changed. The production of nonstoichiometric diffusion tunnels did not occur. The surface attack was quite uniform and some crystal growth did occur. However, the amount of "reduction" by $H_2/H_2O = 10^6$ at these temperatures results in a much larger weight loss. This would indicate that the concentration of $Ti_I$ would be even larger. The activation energy for motion of $Ti_I$ is apparently between 0.5 ev and 0.75 ev from the CO/CO$_2$ results. Thus, one would expect a rapid regrowth on the $O_2$ surface. This author considers that the $H_2$ reduction leads to $H_i$ and to a reduced concentration of $Ti_I$ with the weight losses only apparent due to loss of $T_i$ from the solid as a result of a gaseous species. Also, the O-H bond would increase the activation energy for diffusion.

Figure 47a. $O_2$ Surface Using $H_2/H_2O$ and $O_2$ Gases (X 5.7)
Figure 47b. \( \text{H}_2/\text{H}_2\text{O} \) Surface Using \( \text{H}_2/\text{H}_2\text{O} \) and \( \text{O}_2 \) Gases (X 5.7)

Figure 48. Cross Section of Sample Shown in Figure 47 (X 72)
The hydrogen atom would be in a void position that would reduce the fraction of interstitials sites available for forward diffusion jumps.

2. **Loss of Weight Data**

There have been two previous thermogravimetric studies performed on TiO$_2$ and published. (Reference 10 and 11.) This portion of the experimental work was performed to see if similar results could be obtained and to determine which gases could be considered interacting and noninteracting, and to see if consistent results could be obtained with different samples cut from a vernuel flame fusion grown TiO$_2$ boule. The TiO$_2$ boules are known to have considerable impurities and a variation in impurities with position in the boule.

The initial experiments were performed with argon gas having the following impurities

\[
\begin{align*}
N_2 & \rightarrow 5 \text{ ppm.} \\
O_2 & \rightarrow 5 \text{ ppm.} \\
H_2 & \rightarrow 5 \text{ ppm.} \\
CO_2 & \rightarrow 1 \text{ ppm.} \\
\text{Hydrocarbons}& \rightarrow <1 \text{ ppm.}
\end{align*}
\]

If one excludes the hydrocarbons the partial pressure of oxygen is approximately $2.5 \times 10^{-6}$ mm, Hg. the equivalent percent loss of oxygen which would result in either oxygen vacancies or titanium interstitials. The data was quite scattered as indicated in Table 6:

*Table 6. Reduction Data*

<table>
<thead>
<tr>
<th>Temp</th>
<th>Equivalent percent loss of oxygen.</th>
</tr>
</thead>
<tbody>
<tr>
<td>872</td>
<td>0.00025</td>
</tr>
<tr>
<td>1084</td>
<td>0.00799</td>
</tr>
<tr>
<td>1086</td>
<td>0.00175</td>
</tr>
<tr>
<td>1179</td>
<td>0.00234</td>
</tr>
<tr>
<td>1249</td>
<td>0.0140</td>
</tr>
<tr>
<td>1258</td>
<td>0.0132</td>
</tr>
<tr>
<td>1275</td>
<td>0.0262</td>
</tr>
</tbody>
</table>
The two samples at 1084°C and 1086°C gave very widely scattered results indicating that the number of samples necessary to yield a 95 percent confidence limit would be considerable. The results at 1249°C and 1258°C were more consistent than the 1085°C samples. An increase in temperature did show an increase in reduction in spite of the wide scatter.

Two samples were reduced in a vacuum of 10^{-6} \text{ mm Hg} at 1179°C and 1275°C. The results are shown in Table 7.

Table 7. Vacuum Reduction

<table>
<thead>
<tr>
<th>Temp</th>
<th>Equivalent percent loss of oxygen.</th>
</tr>
</thead>
<tbody>
<tr>
<td>1179°C</td>
<td>0.0325%</td>
</tr>
<tr>
<td>1275°C</td>
<td>0.0357%</td>
</tr>
</tbody>
</table>

One sample was reduced in H_2 at 745°C resulting in 2.12 percent loss of oxygen.

Three samples were reduced in CO and are shown in Table 8.

Table 8. CO Reduction

<table>
<thead>
<tr>
<th>Temp</th>
<th>Equivalent percent loss of oxygen.</th>
</tr>
</thead>
<tbody>
<tr>
<td>786°C</td>
<td>0.0357% % loss of oxygen.</td>
</tr>
<tr>
<td>1002°C</td>
<td>0.307</td>
</tr>
<tr>
<td>1002°C</td>
<td>0.251</td>
</tr>
</tbody>
</table>

At 1002°C the scatter appears quite large showing that many samples would be needed for a 95 percent confidence limit.

3. Calculation of the Diffusivity

The rate of growth can be approximated by the following equation:

$$\frac{dx}{dt} = \Omega \frac{\Delta c}{\Delta x}$$

where

- $dx$ = increases in $\Delta x$ with time
- $\Omega$ = unit cell volume of TiO_2
\[ D = D_0 \exp \left( -\frac{\Delta H_m}{KT} \right) \]
\[ \Delta c = \text{concentration on reducing surface} \]
\[ \Delta x = \text{original thickness of crystal.} \]

This is only a rough calculation for the following reasons:

1. Nonstoichiometric diffusion etching causes an indeterminable variation in \( \Delta x \) and \( \Delta c \). The variation with time is also unknown.

2. Growth on the \( O_2 \) surface is greater at the edges of the specimen seals with local variations in thickness across the \( O_2 \) surface.

3. Surface impurities and preparation may impede surface reaction rates so that concentration gradients are less than that expected from equilibrium conditions.

However, an order of magnitude calculation can be made that fits most of the experimental by assuming the following:

1. \( \Delta x \approx 0.75 \) the original thickness

2. \( \Delta c \) equal to the equilibrium concentration using Kofstead's data on the reduction surface and assuming \( Ti_1 \) rather than \( V_0 \).

3. \( dx \) equal to the growth thickness in the center of the \( O_2 \) surface.

Using these approximations, the value of \( D \) that fits within an order of magnitude is \( D = 10^{-5} \text{ cm}^2/\text{sec} \).

The quenching of the concentration gradient was attempted several times but the nature of the apparatus would not allow quenching from diffusion temperatures to room temperature in less than 20 minutes. The blue color, significant of reduced \( TiO_2 \), was never apparent in the \( CO/CO_2 \) reduced samples. However, this is not surprising for the activation energy of formation is significantly greater than the activation energy for motion. The production of \( Ti_1 \) would be reduced greatly with a reduction in temperature but, the diffusion and oxidation of \( Ti_1 \) on the \( O_2 \) surface could still occur. The \( H_2/H_2O \) samples, however, had
the nonstoichiometric color which would indicate that the activation energy of motion is higher or that the nonstoichiometry is due to O-H bonds.

D. EXPERIMENTAL CONCLUSIONS

This experiment proves the existence of titanium interstitials as a nonstoichiometric species in TiO₂. The concentration of defects varies inversely with oxygen pressure. N-type conductivity exist in nonstoichiometric TiO₂. Therefore, two possibilities exist for the nonstoichiometric specie, i.e., Ti⁺⁺⁺ or Vo; Ti⁺⁺⁺ is the only defect of the two that could produce regrowth on the O₂ surface. Any existence of Vo could be determined by the use of a real partial pressure of Ti "gas" on one surface as explained in the theoretical section.

The experimental results show that this experiment can be used as a general tool for the determination of defects using either polycrystalline or single crystal material. The impurity diffusion resulting from a concentration gradient of Ti⁺⁺⁺ shows that Fe, Ag, and Magnesium are interstitial impurities and that Cu, Ca and AL are substitutional impurities. This correlates with previous results concerning iron impurities (Reference 16) and aluminum impurities (Reference 17).

This experiment results in a new method of revealing dislocations by nonstoichiometric diffusion etching producing tunnels at dislocations.

This experiment results in a new method of producing ~100 percent theoretically dense polycrystalline TiO₂.

This experiment reveals the difference between interacting (H₂/H₂O) and noninteracting (CO/CO₂) reduction gases.

This experiment shows the influence of surface preparation on the nonstoichiometric diffusion.

E. GENERAL CONCLUSIONS

A new experimental tool, which relies only on unquestionable fundamental assumptions, has been derived theoretically that will determine the nature of the nonstoichiometric defect in a single experiment.
A new method of crystal growth termed endotaxy has been described which could produce single crystals of high purity.

A new method of reducing the number of edge dislocations has been explained in metal-metalloid systems.

A new method of increasing the density of polycrystalline material has been explained and demonstrated.

If interstitialcy diffusion does not occur this experiment amounts to a new experimental tool to prove that foreign atoms are either in substitutional positions or interstitial positions if the native imperfection is a metal interstitial.

New purification techniques by a membrane experiment have been explained.
V RECOMMENDATIONS

This experimental and theoretical study has a wide range of applications as indicated in the following table.

<table>
<thead>
<tr>
<th>Field</th>
<th>Reason</th>
</tr>
</thead>
<tbody>
<tr>
<td>Metallurgy</td>
<td>Oxidation and tarnishing reactions on metals. Defect studies in order alloys.</td>
</tr>
<tr>
<td>Ceramics</td>
<td>Production of high density polycrystalline ceramics. Defect studies in oxides.</td>
</tr>
<tr>
<td>Electrical Engineering</td>
<td>New p-n, p-i-n, and perhaps tunnel diodes. High quality sensors. Relation between nature of defect and electrical properties.</td>
</tr>
</tbody>
</table>

The USAF, the DOD, and the scientific community in general have many interests and needs which this theoretical and experimental work may fulfill. For example, the cost in time and money of determining the nature of defects can now be decreased. Nevertheless, the quality of the defect information has increased with additional knowledge gained for each crystal system.
The next program is strongly recommended to be a program to classify the native imperfections in metal-metalloid crystals according to their atomic species and crystalline structure. Either polycrystalline or single crystal samples can be used. The more important oxides and sulfides should be determined first.

From this study important facts can be determined for use in the fields of chemistry, metallurgy, ceramics, electrical engineering and other aspects of solid state physics. The second program is strongly recommended to be a study of endotaxial growth using metal partial pressures. This study would determine the quality and extent of endotaxy.

The third program should be a determination of the equilibrium constants which will yield an accurate description of the native imperfection concentrations. The method of separation of D and C by Rosenberg’s techniques are recommended. (Reference 17.)

The applications in the fields of electrical engineering, metallurgy, and ceramics will unfold as the above programs are in progress. A theoretical investigation should be instigated to study the applicability of these experimental techniques to all ordered systems, e.g., the metal-metal ordered alloys.
REFERENCES


REFERENCES (CONT'D)


Single and polycrystalline TiO₂ (Rutile) membrane experiments were performed using two different partial pressures of O₂ at temperatures from 900°C to 1200°C. Crystalline regrowth on the high partial pressure O₂ surface under a variety of conditions is convincing proof of the existence of the titanium interstitials. Diffusion tunneling of dislocations occurred in the single crystal experiments. Purification of the single crystals of foreign impurities (Fe, Ag, and Mg) occurred. The regrowth of the polycrystalline sample approached 100 percent theoretical density. The general determination of nonstoichiometric defects and endotoxial crystal growth is considered theoretically.
Nonstoichiometry  
Oxides  
Defects  
Crystal Growth  
Dislocations  
Titanium Dioxide  
Purification  

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